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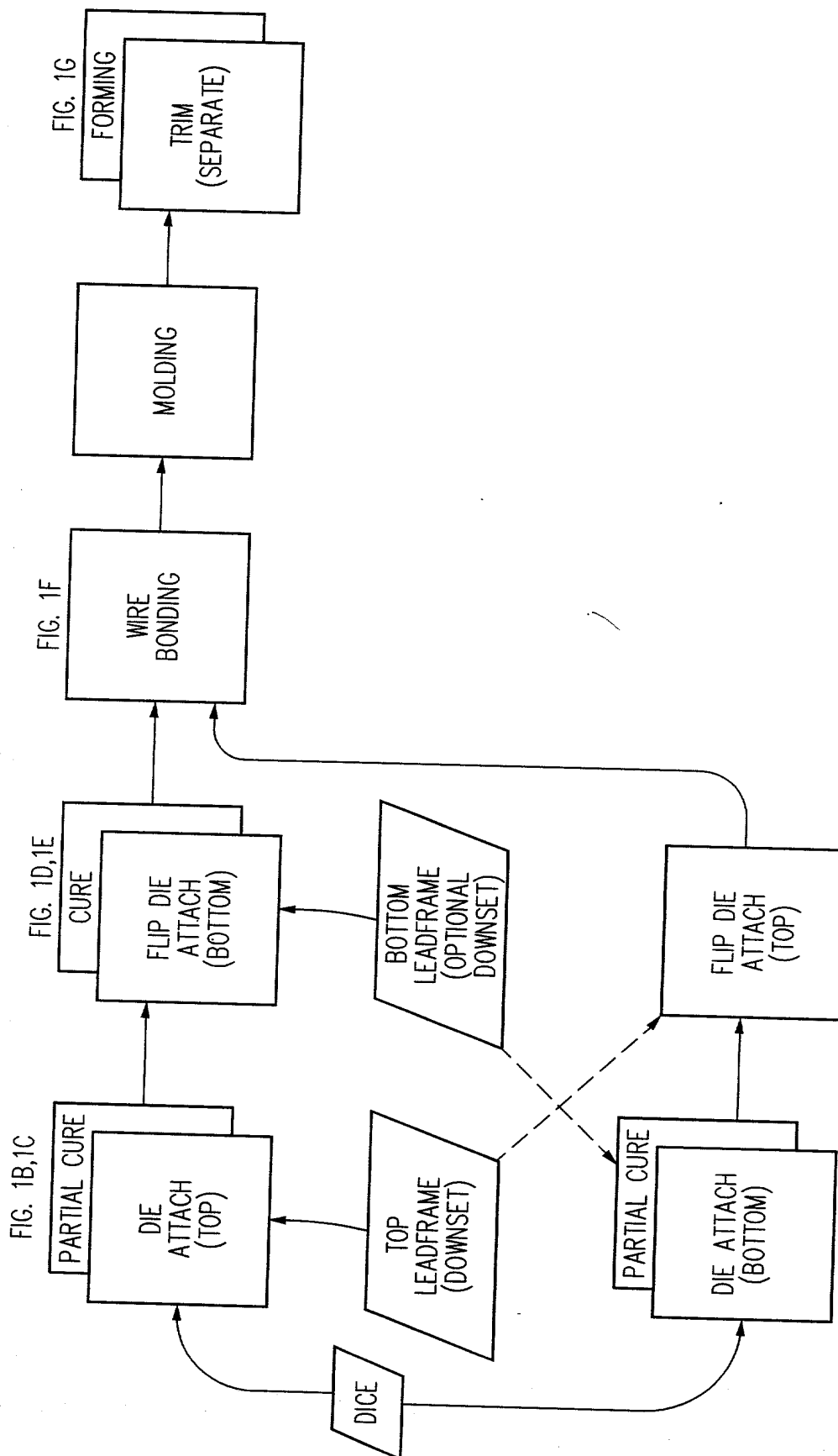


FIG. 1A
(PRIOR ART)

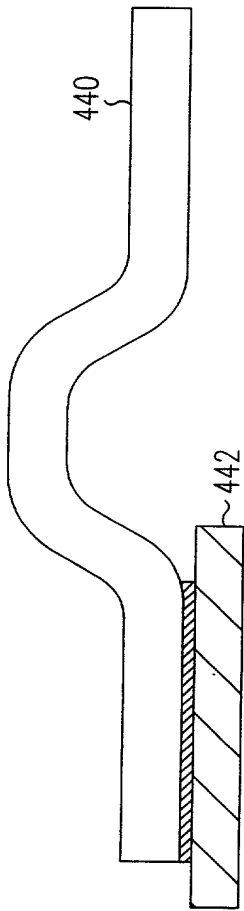


FIG. 1B
(PRIOR ART)

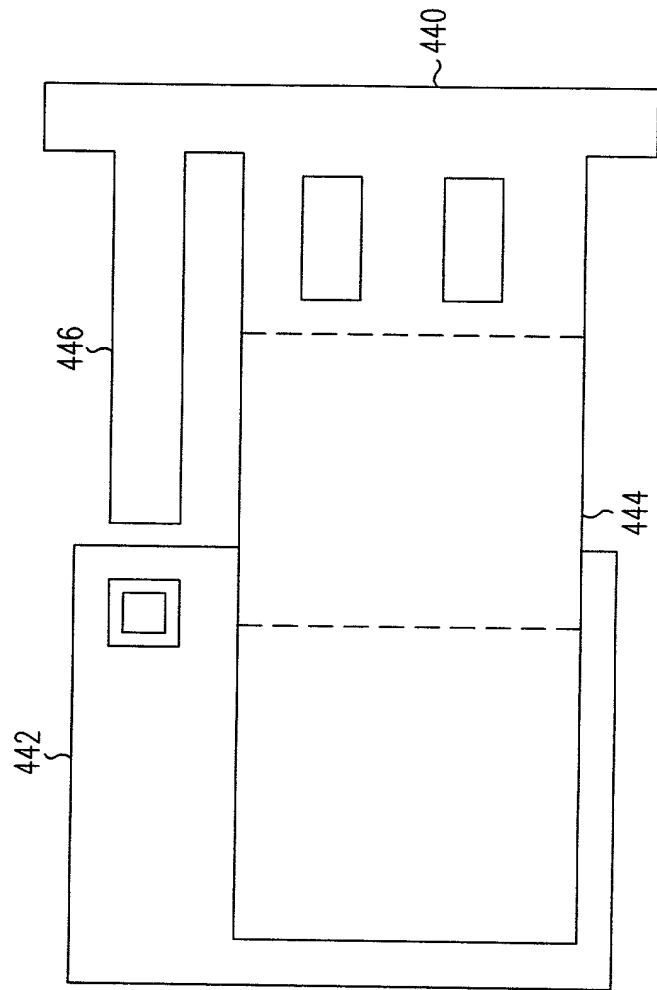


FIG. 1C
(PRIOR ART)

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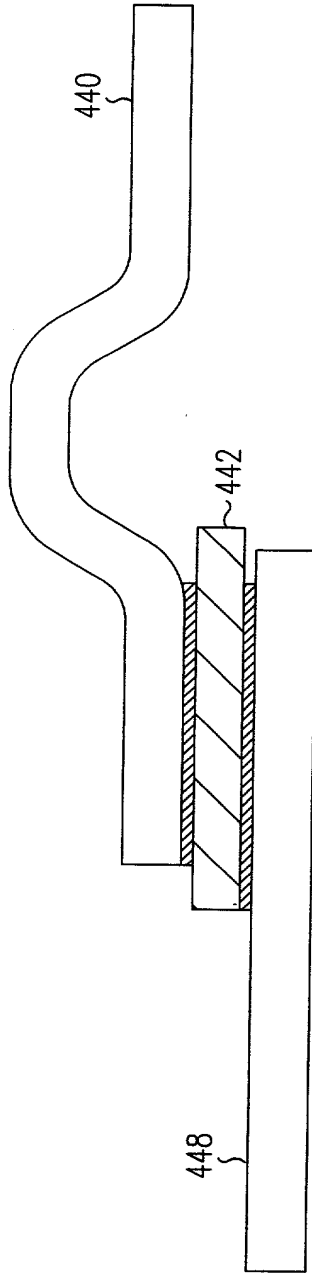


FIG. 1D
(PRIOR ART)

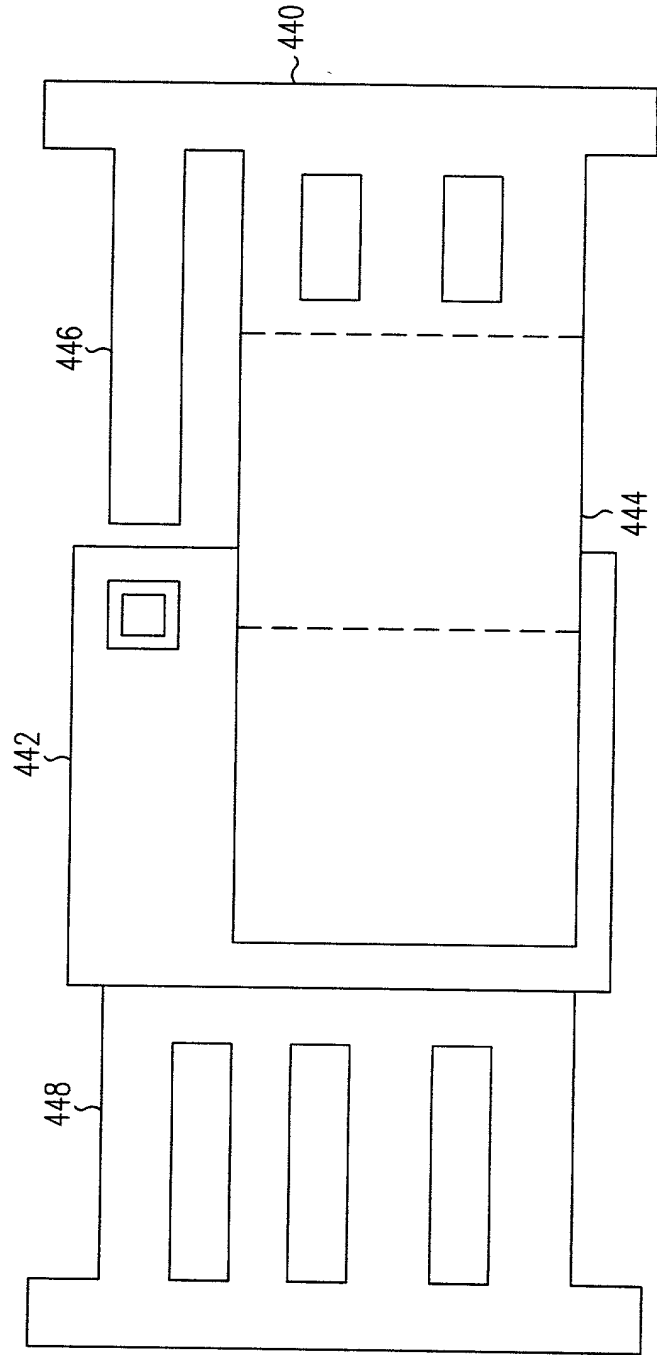
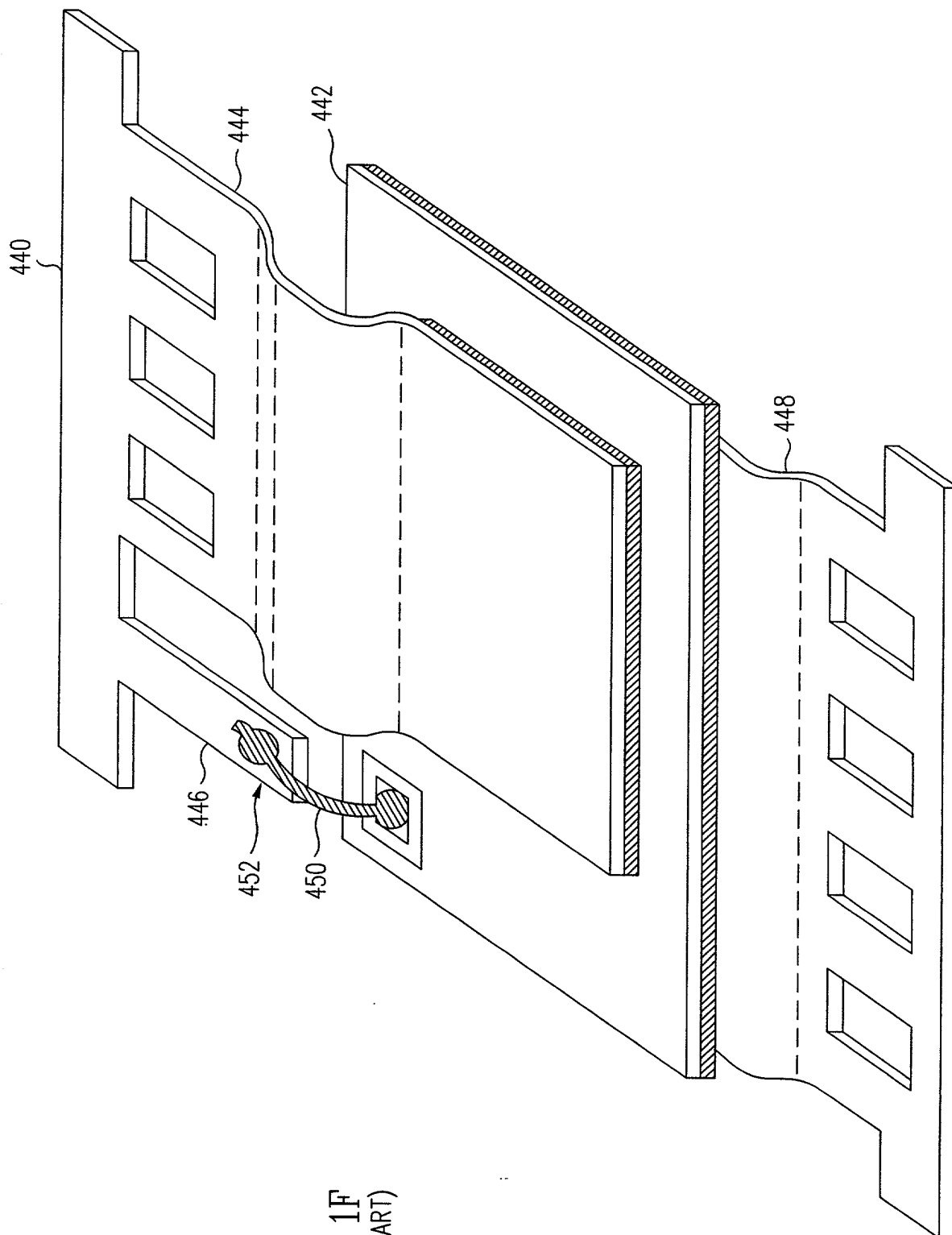


FIG. 1E
(PRIOR ART)



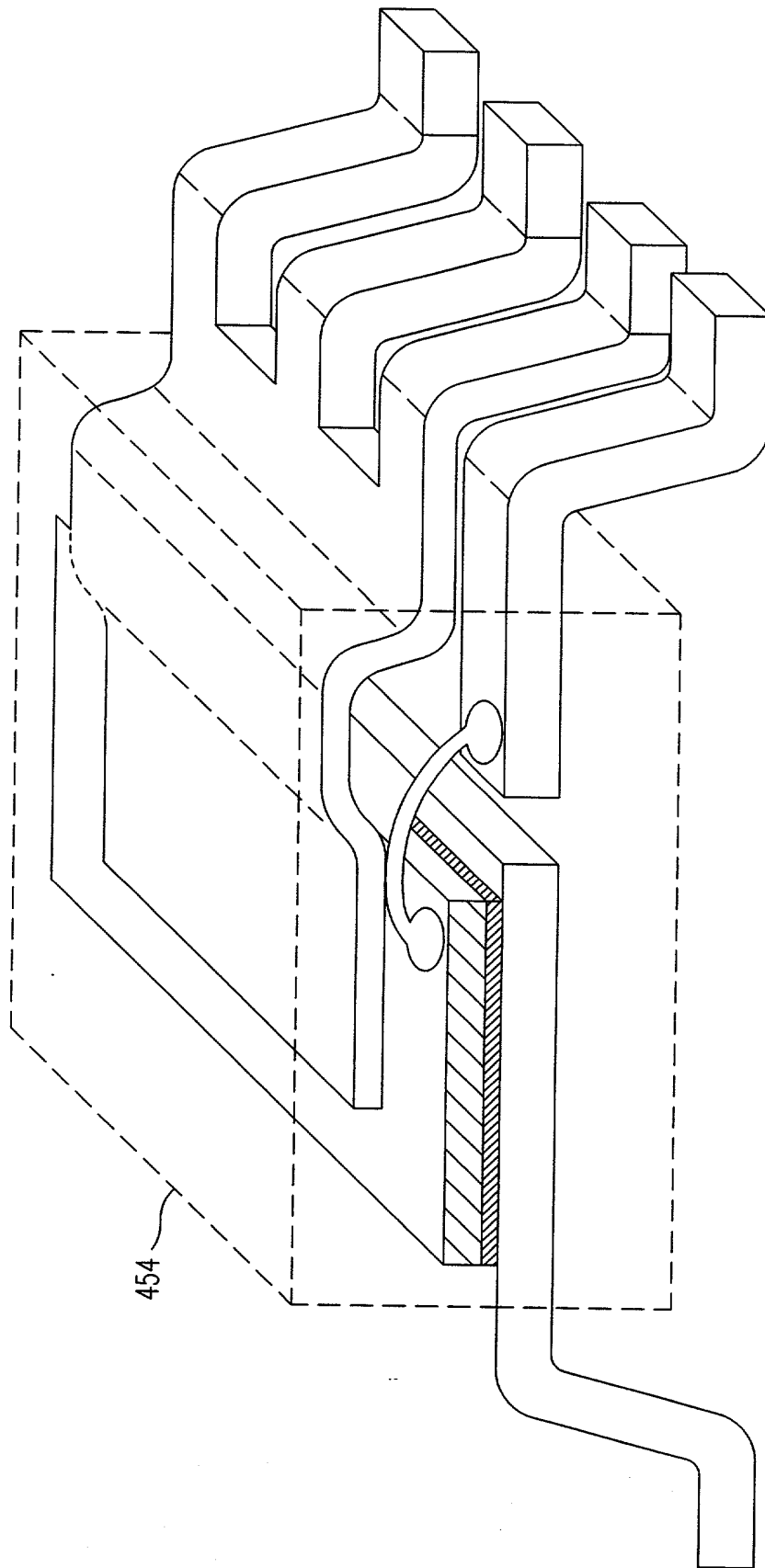


FIG. 1G
(PRIOR ART)

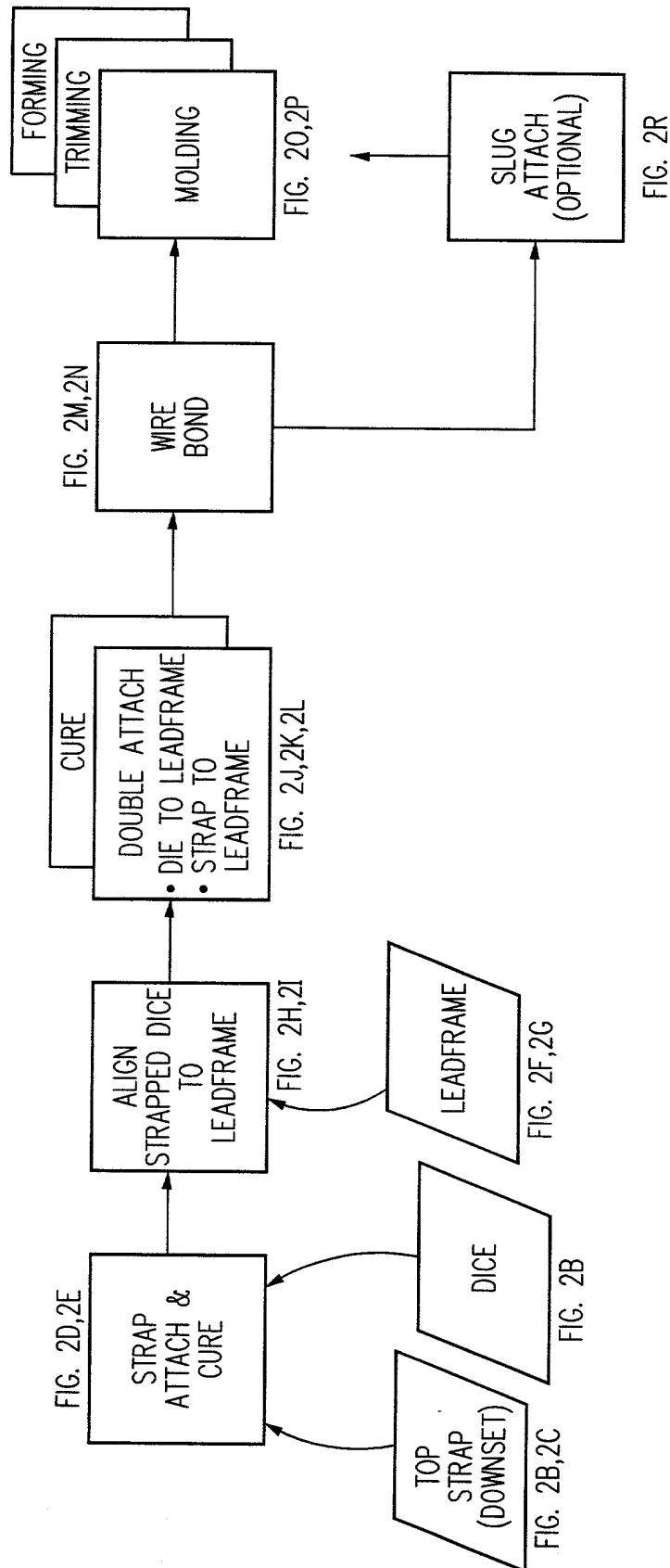


FIG. 2A
(PRIOR ART)

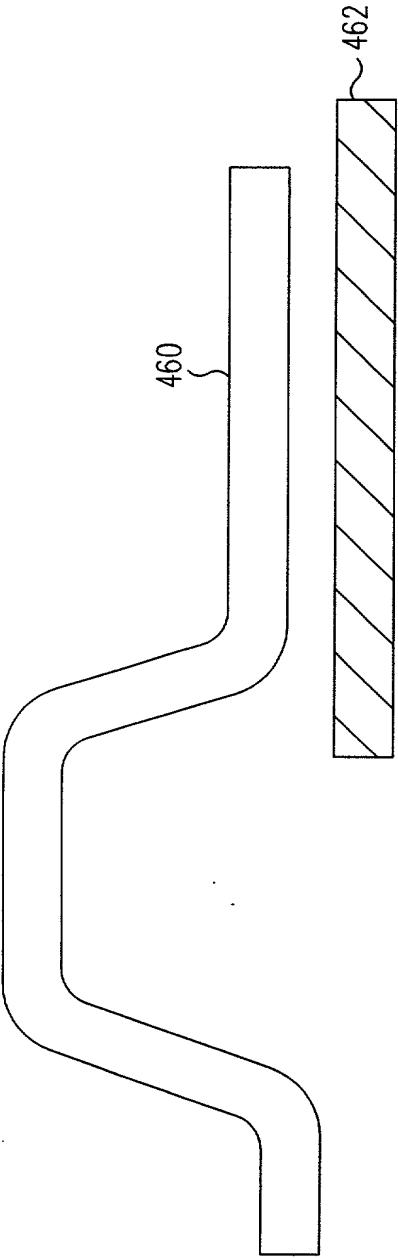


FIG. 2B
(PRIOR ART)

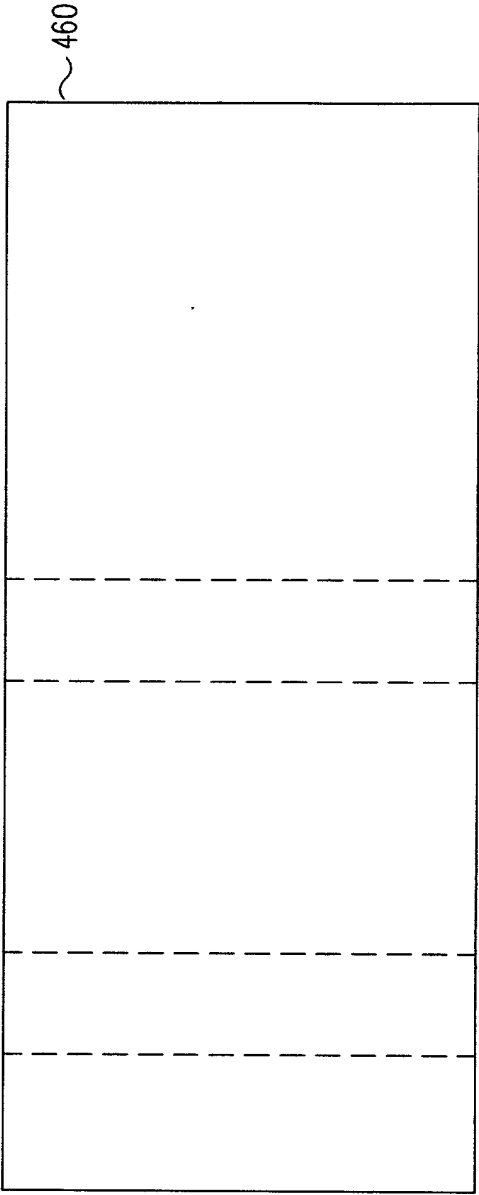


FIG. 2C
(PRIOR ART)

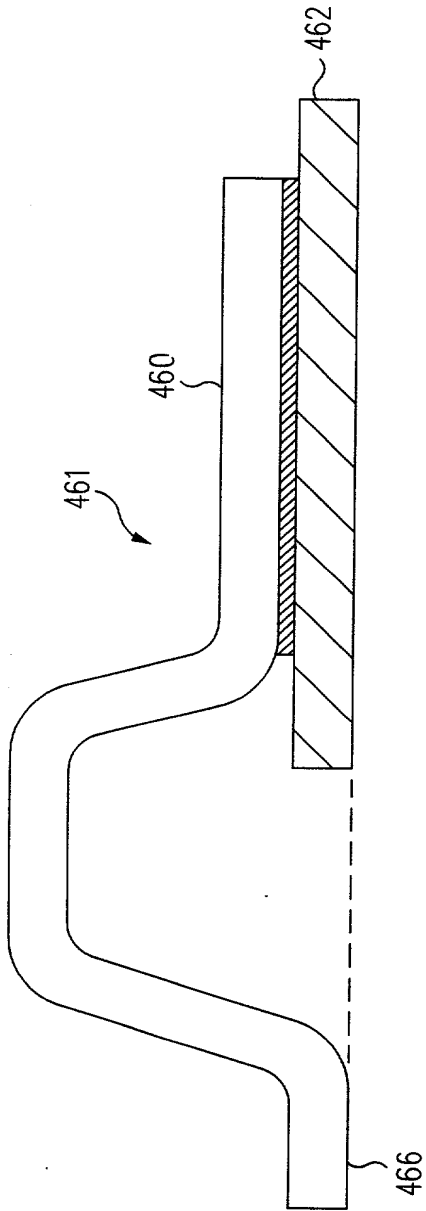


FIG. 2D
(PRIOR ART)

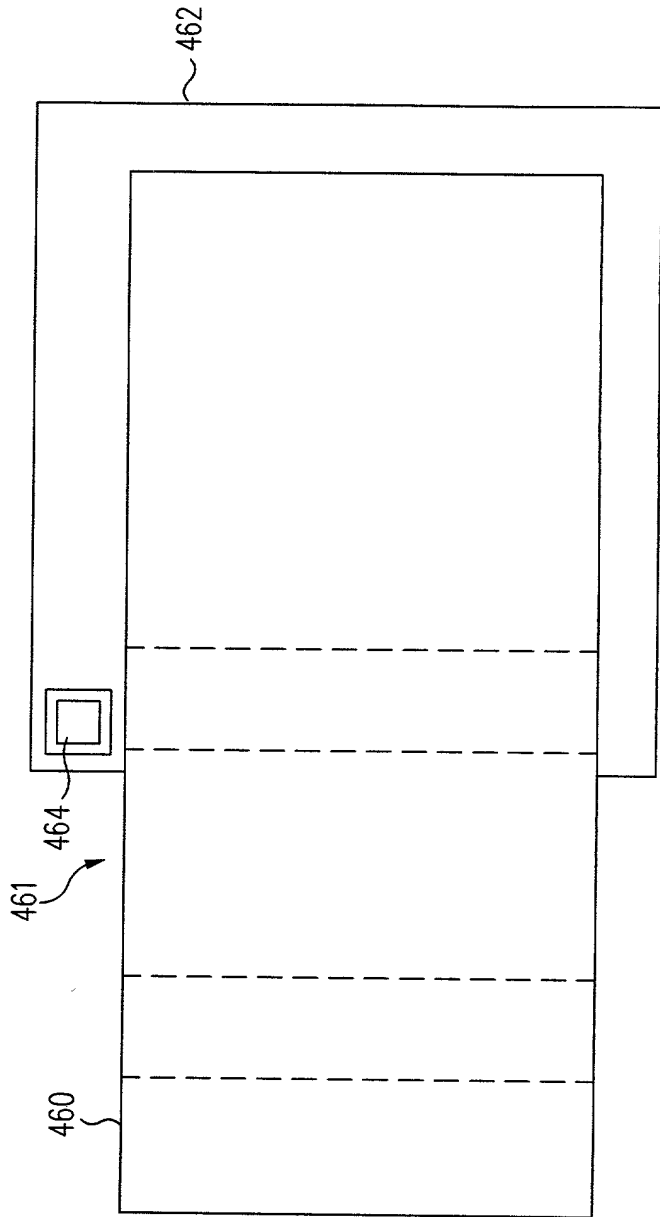


FIG. 2E
(PRIOR ART)

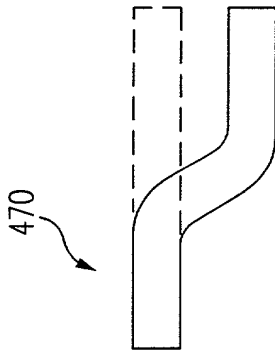


FIG. 2F
(PRIOR ART)

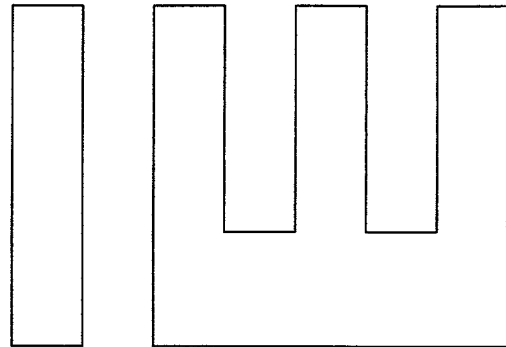
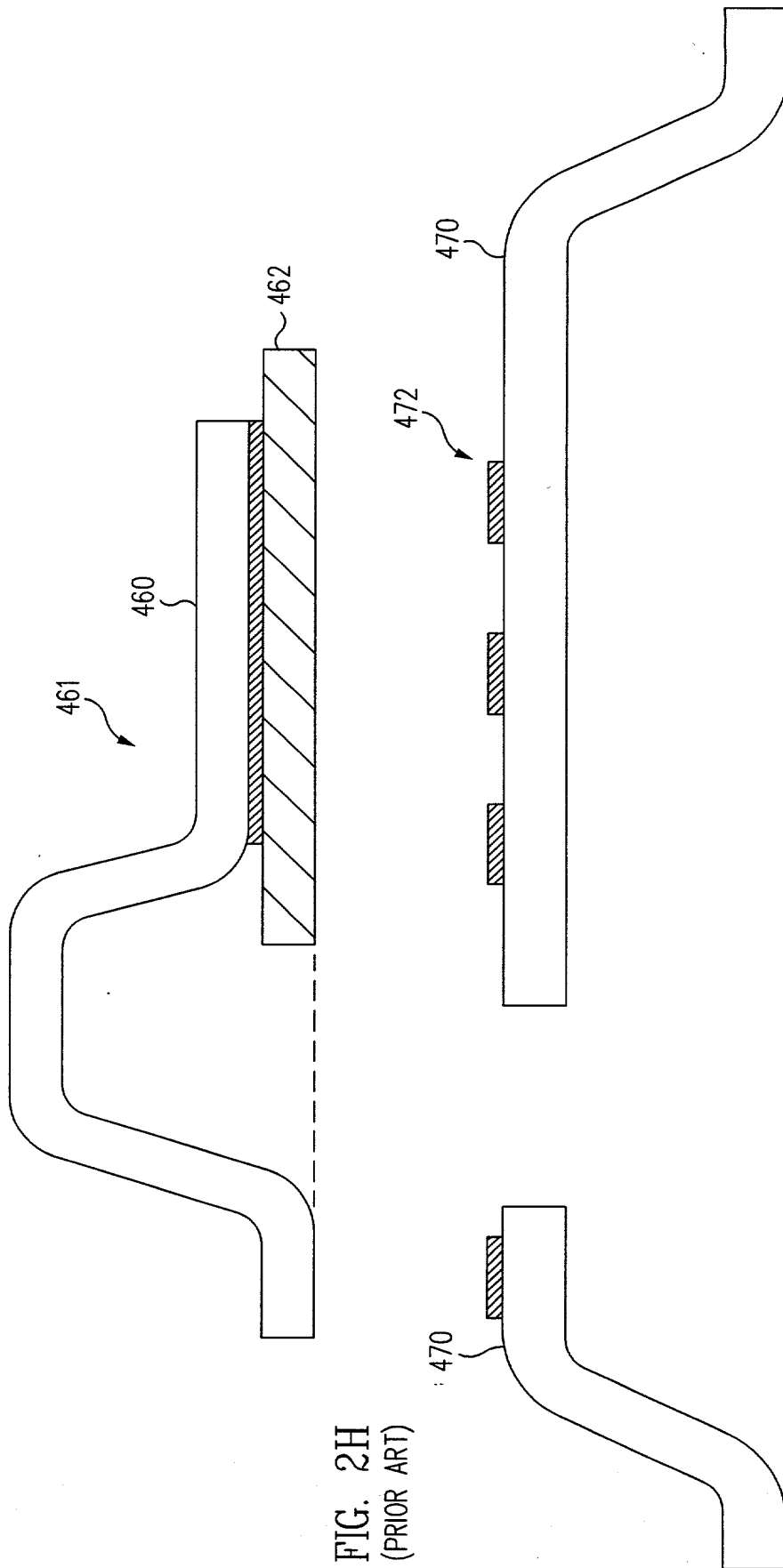


FIG. 2G
(PRIOR ART)



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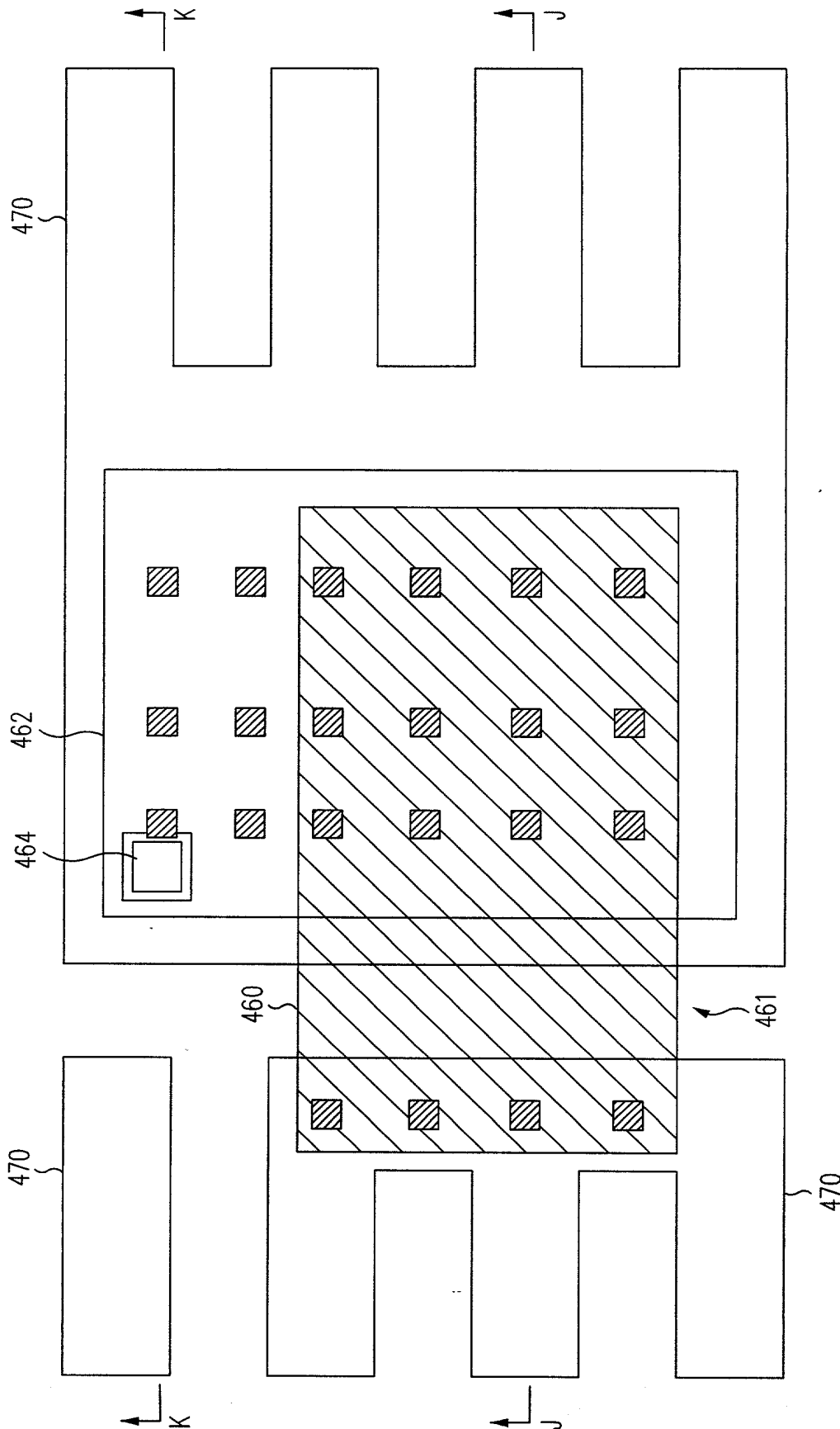


FIG. 2I
(PRIOR ART)

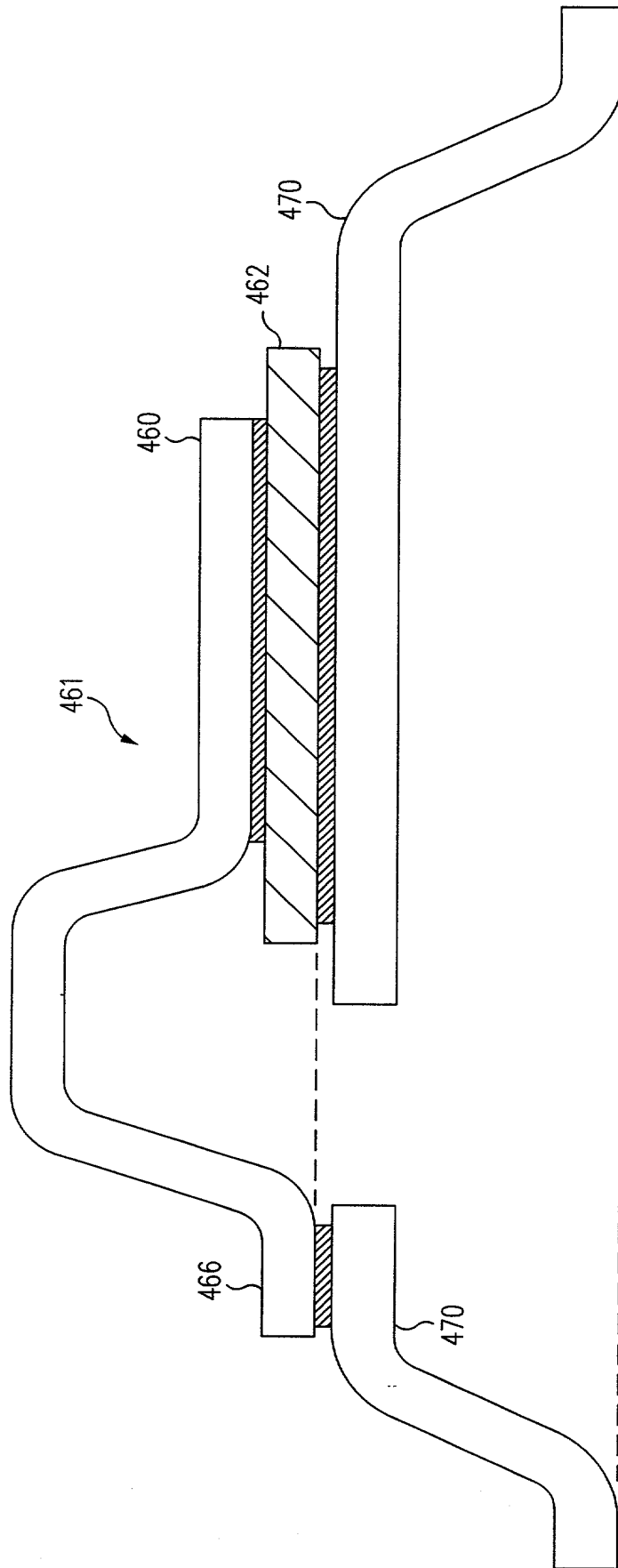


FIG. 2J
(PRIOR ART)

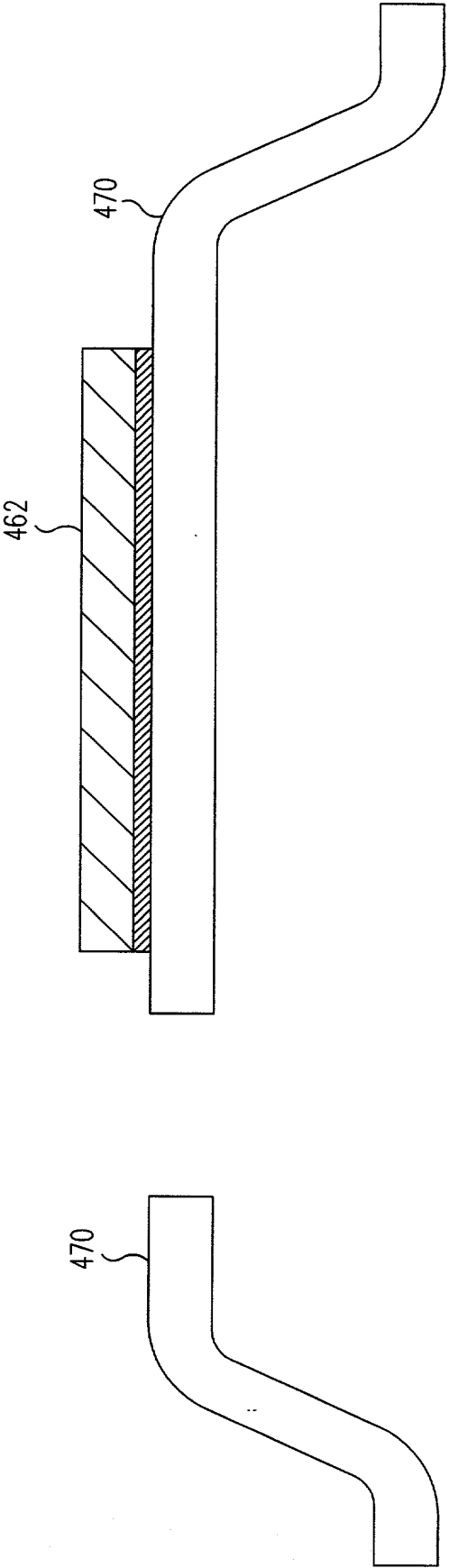
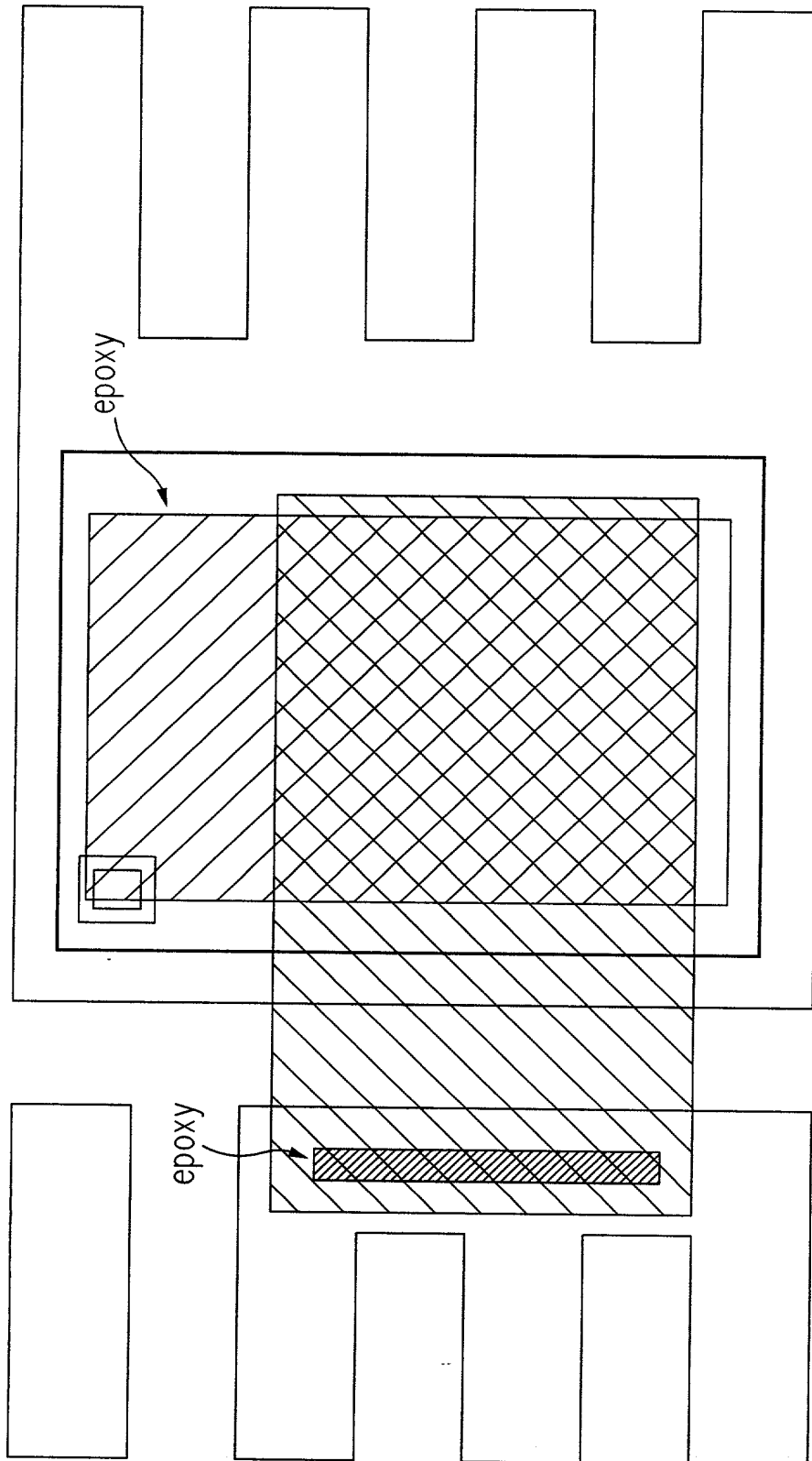


FIG. 2K
(PRIOR ART)

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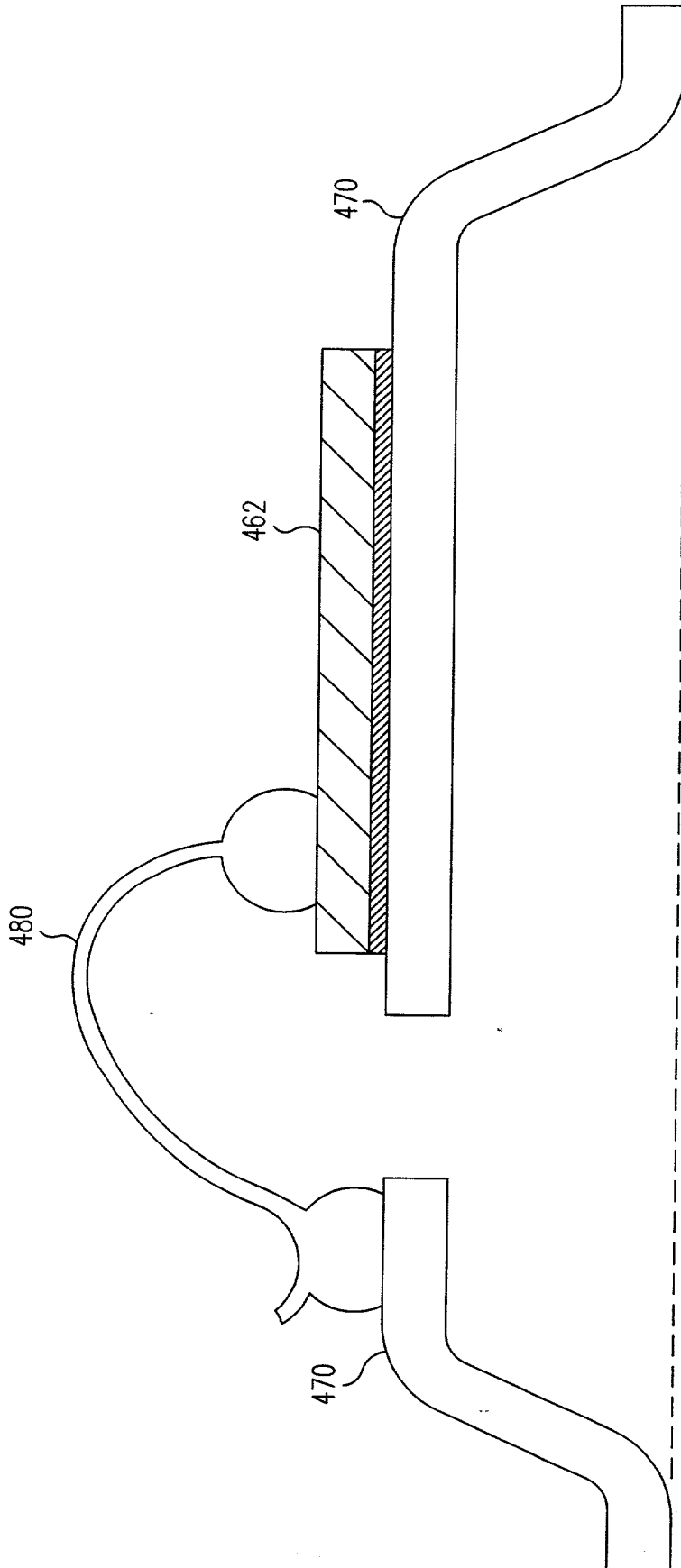


FIG. 2M
(PRIOR ART)

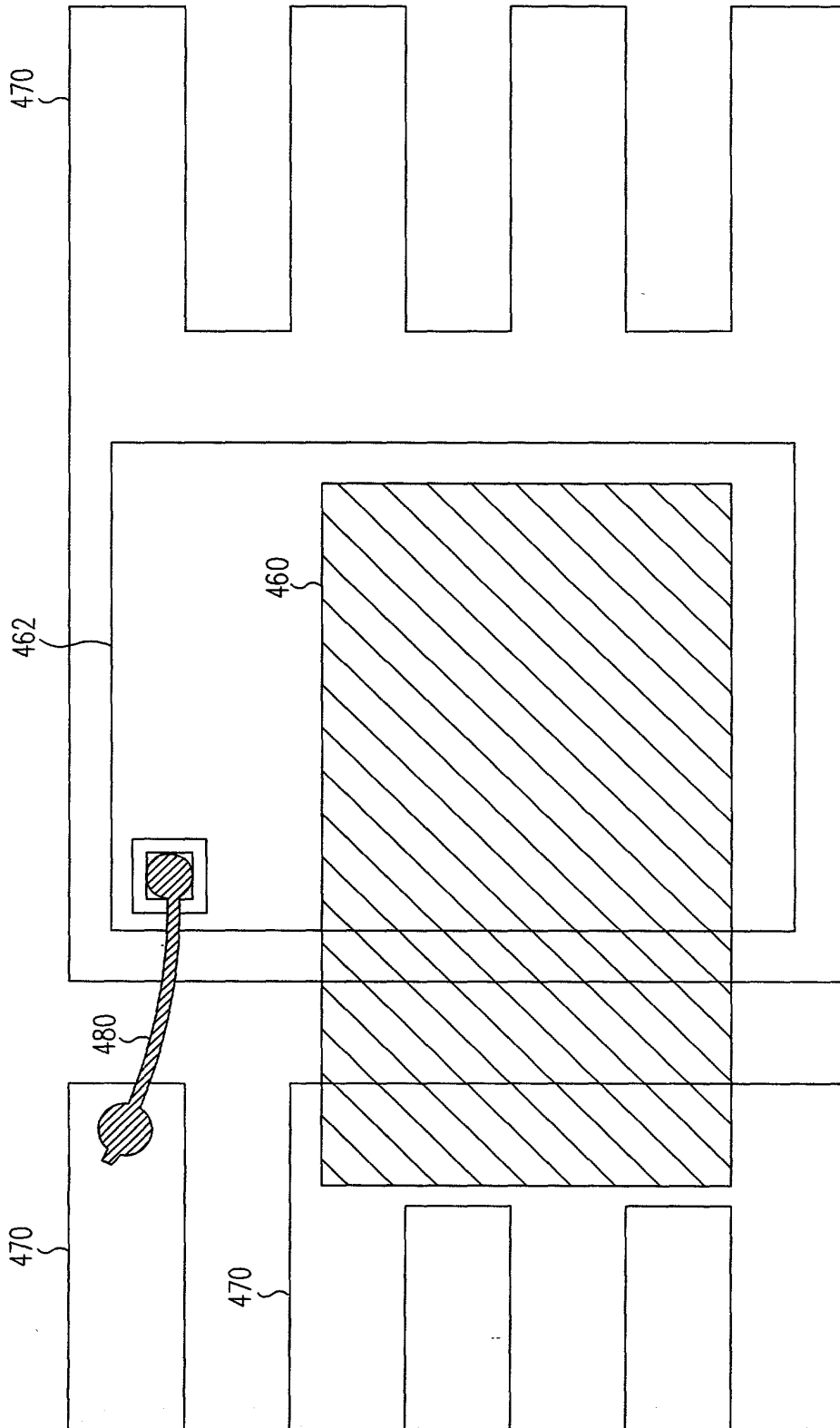


FIG. 2N
(PRIOR ART)

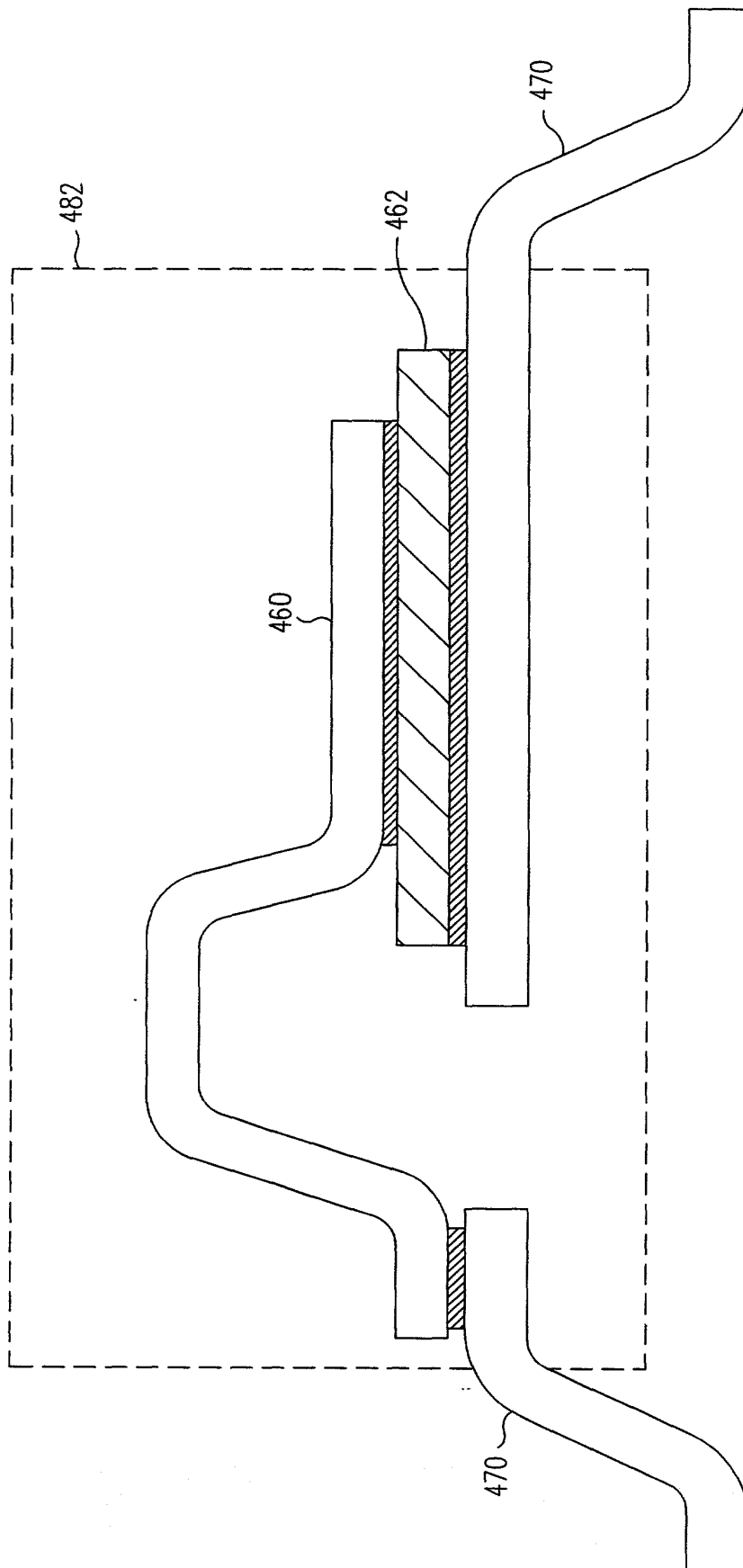


FIG. 20
(PRIOR ART)

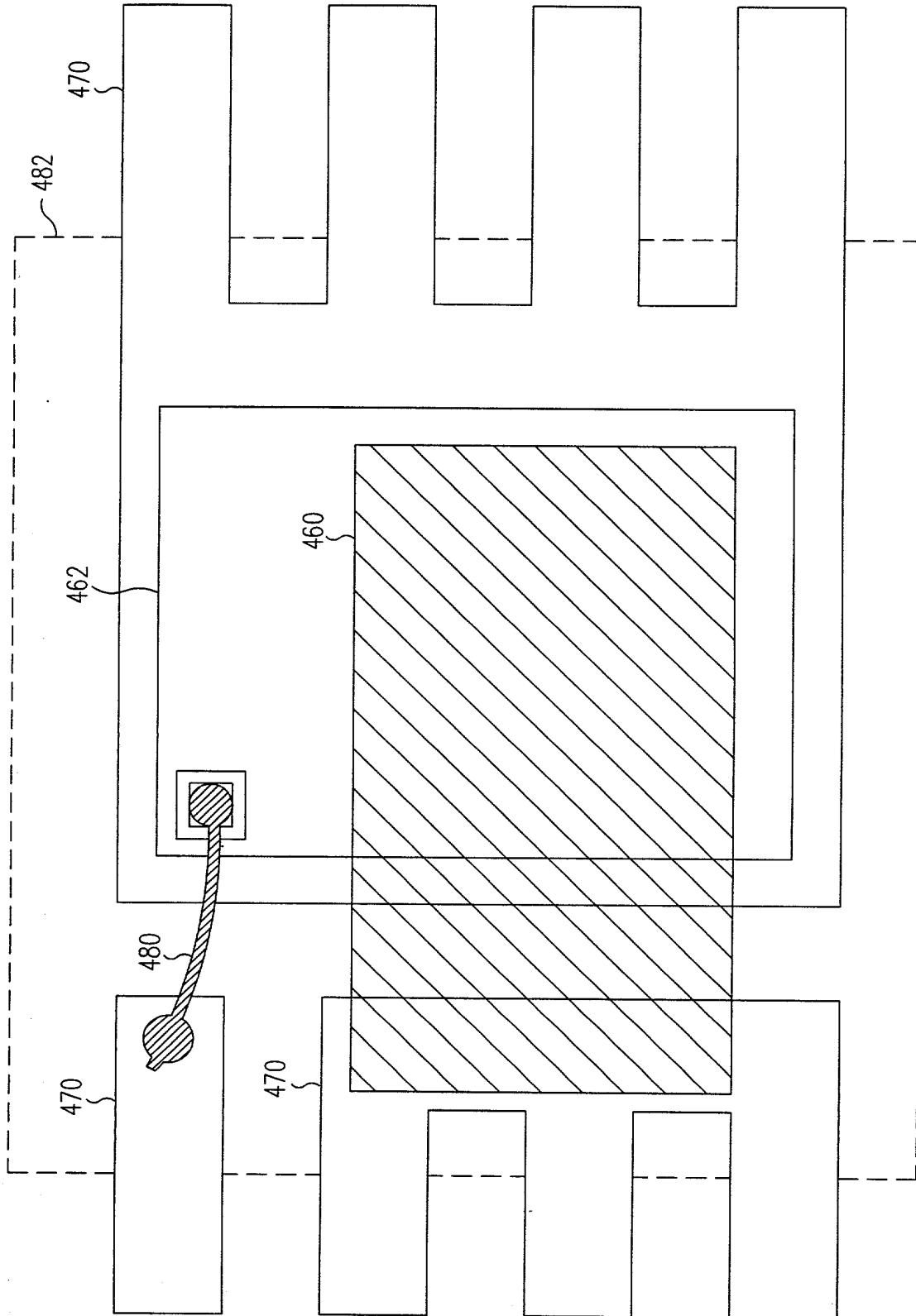


FIG. 2P
(PRIOR ART)

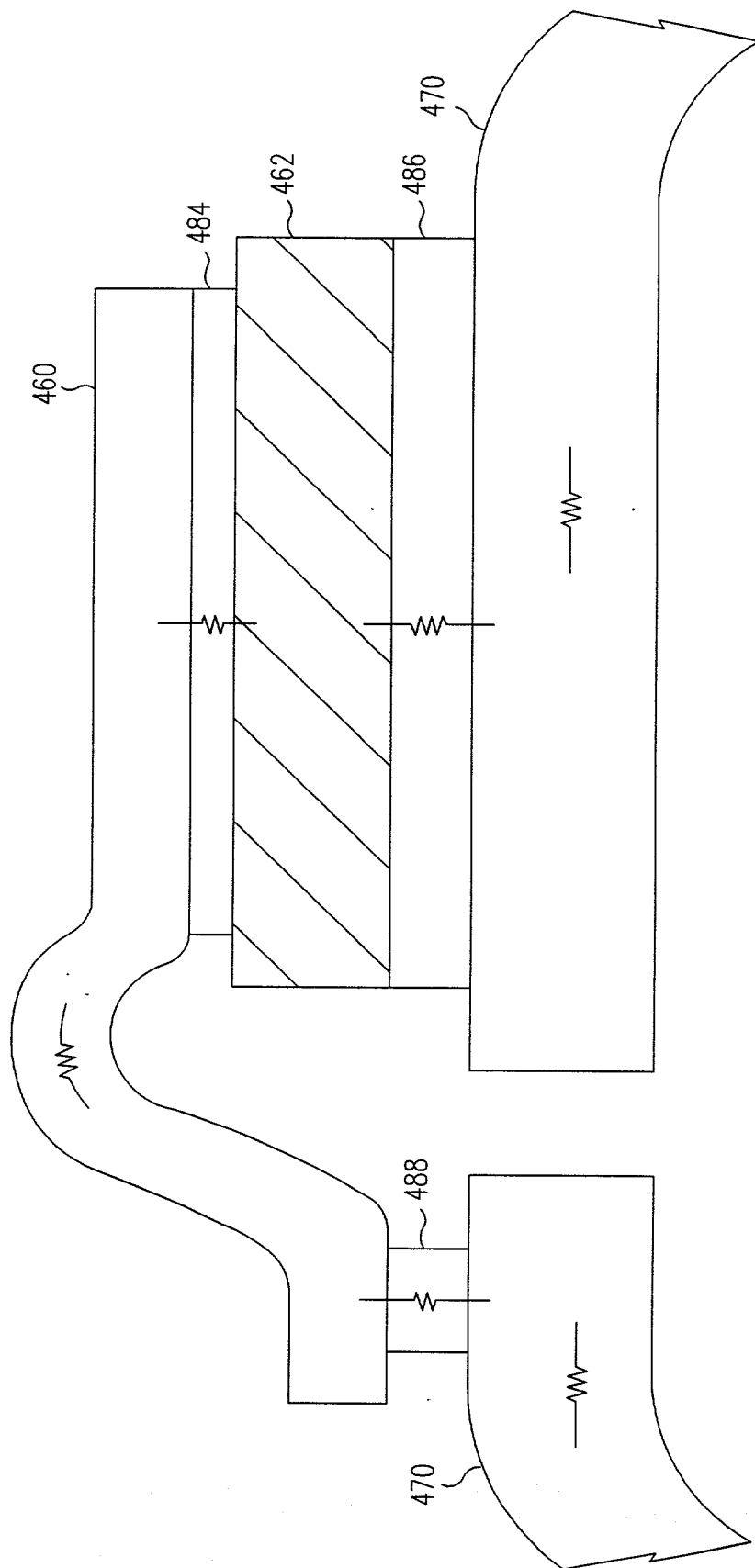


FIG. 2Q
(PRIOR ART)

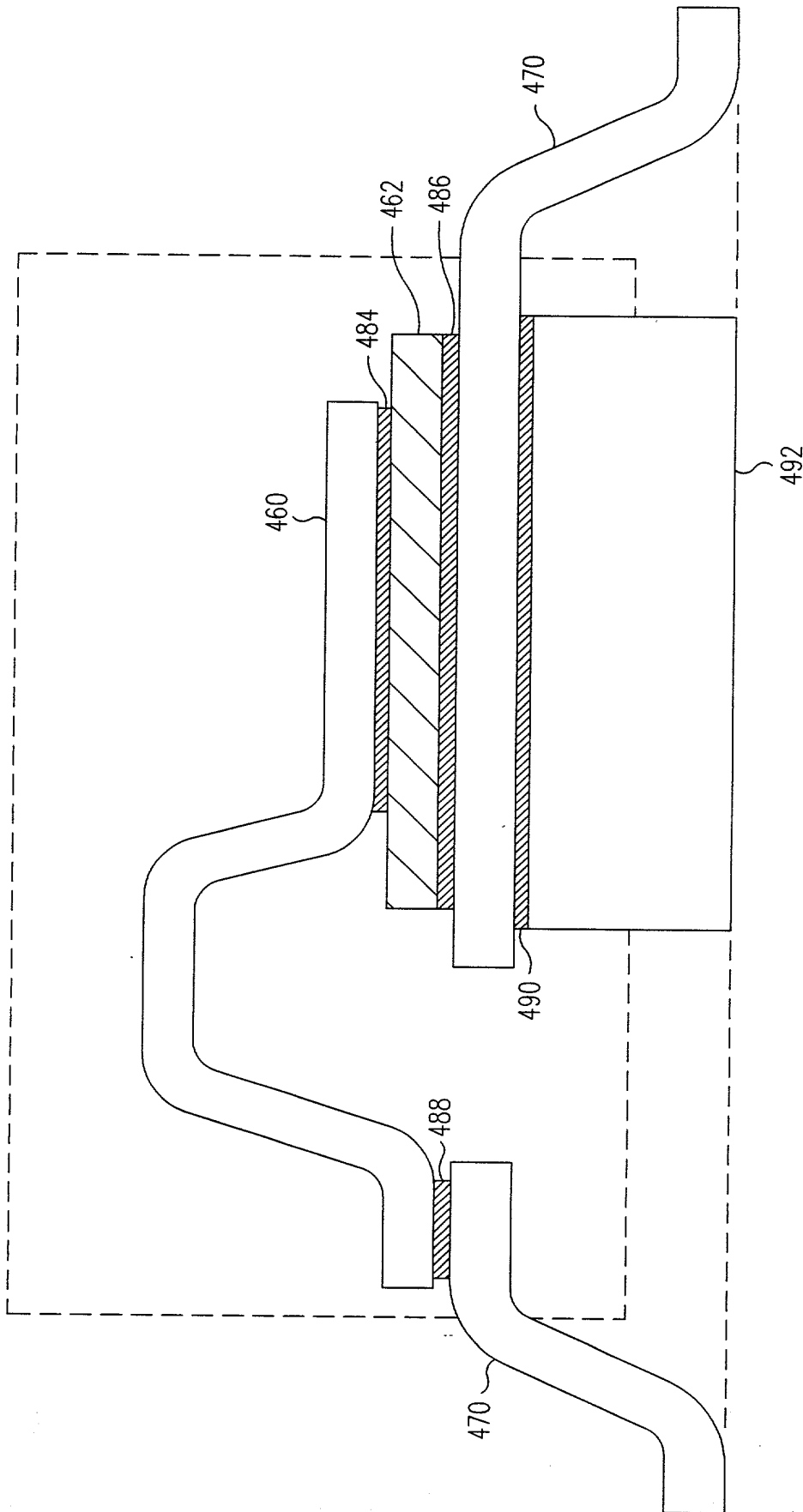


FIG. 2R
(PRIOR ART)

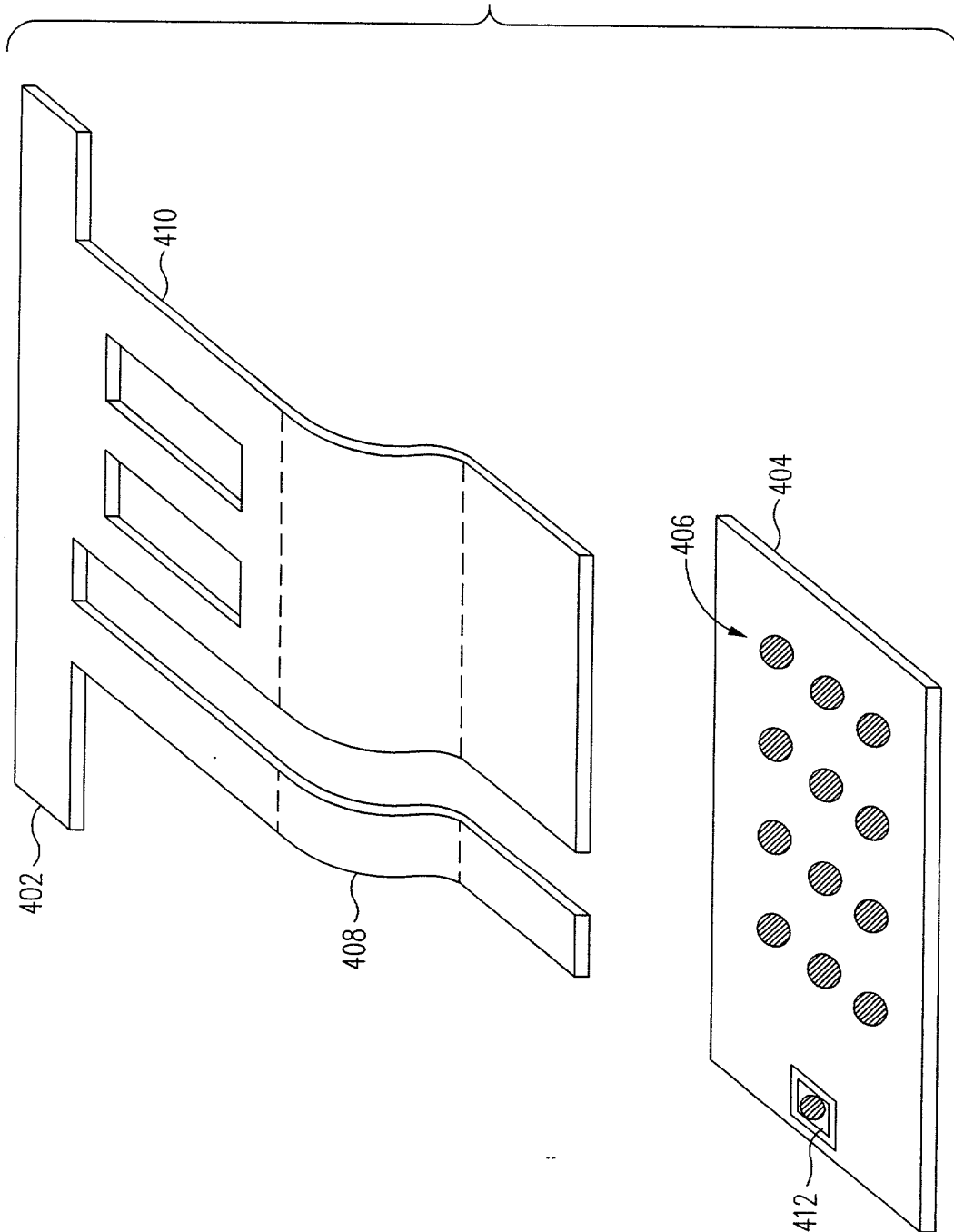


FIG. 3A
(PRIOR ART)

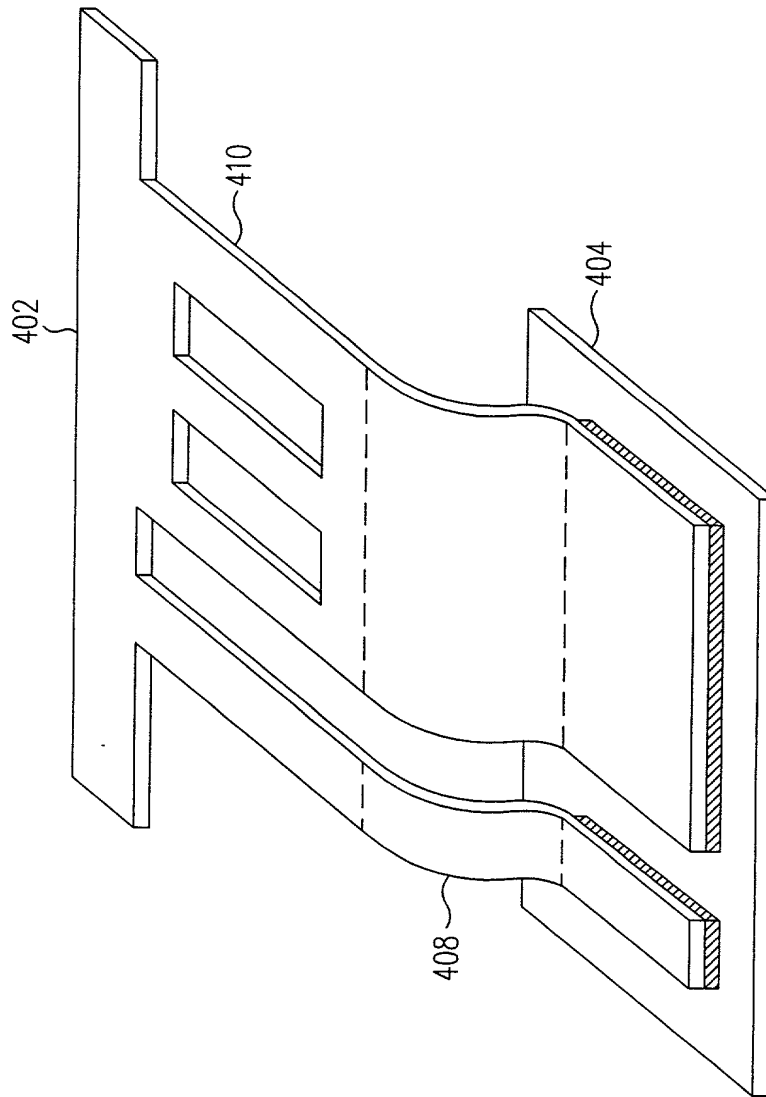
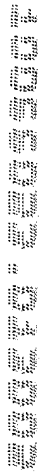


FIG. 3B
(PRIOR ART)

[illegible]

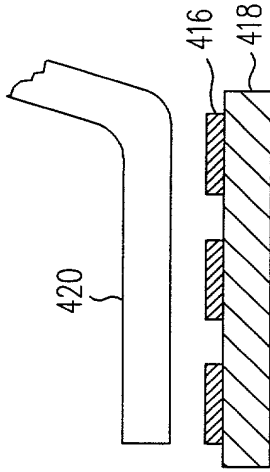


FIG. 3E
(PRIOR ART)

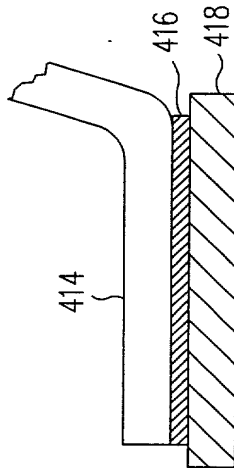


FIG. 3D
(PRIOR ART)

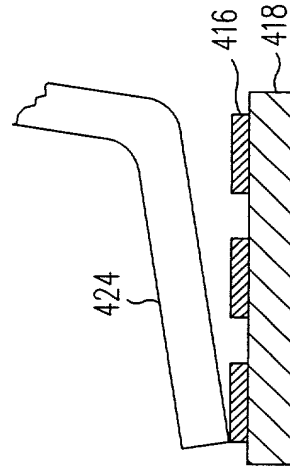


FIG. 3G
(PRIOR ART)

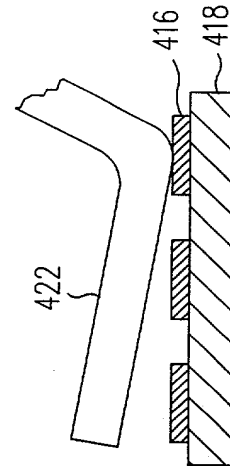


FIG. 3F
(PRIOR ART)

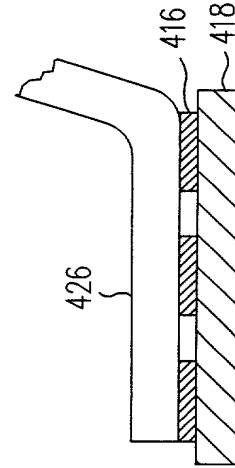


FIG. 3H
(PRIOR ART)

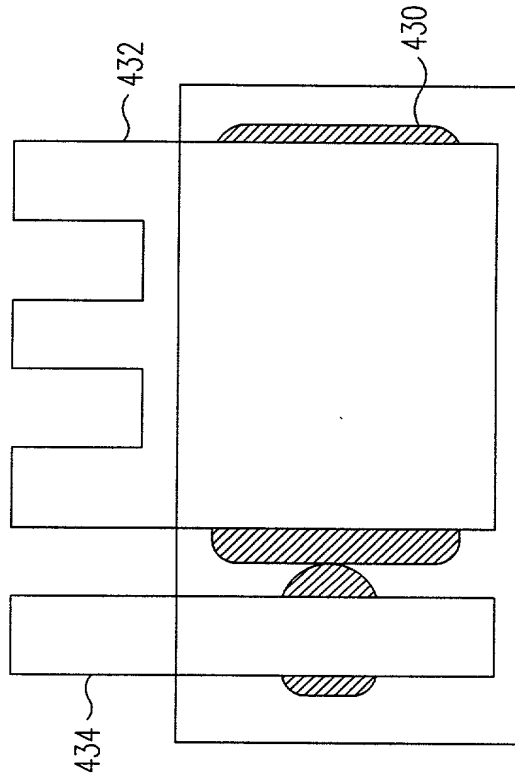


FIG. 4B
(PRIOR ART)

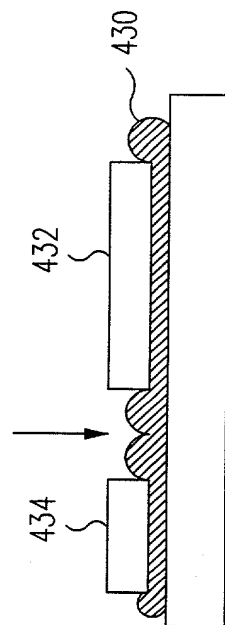


FIG. 4A
(PRIOR ART)

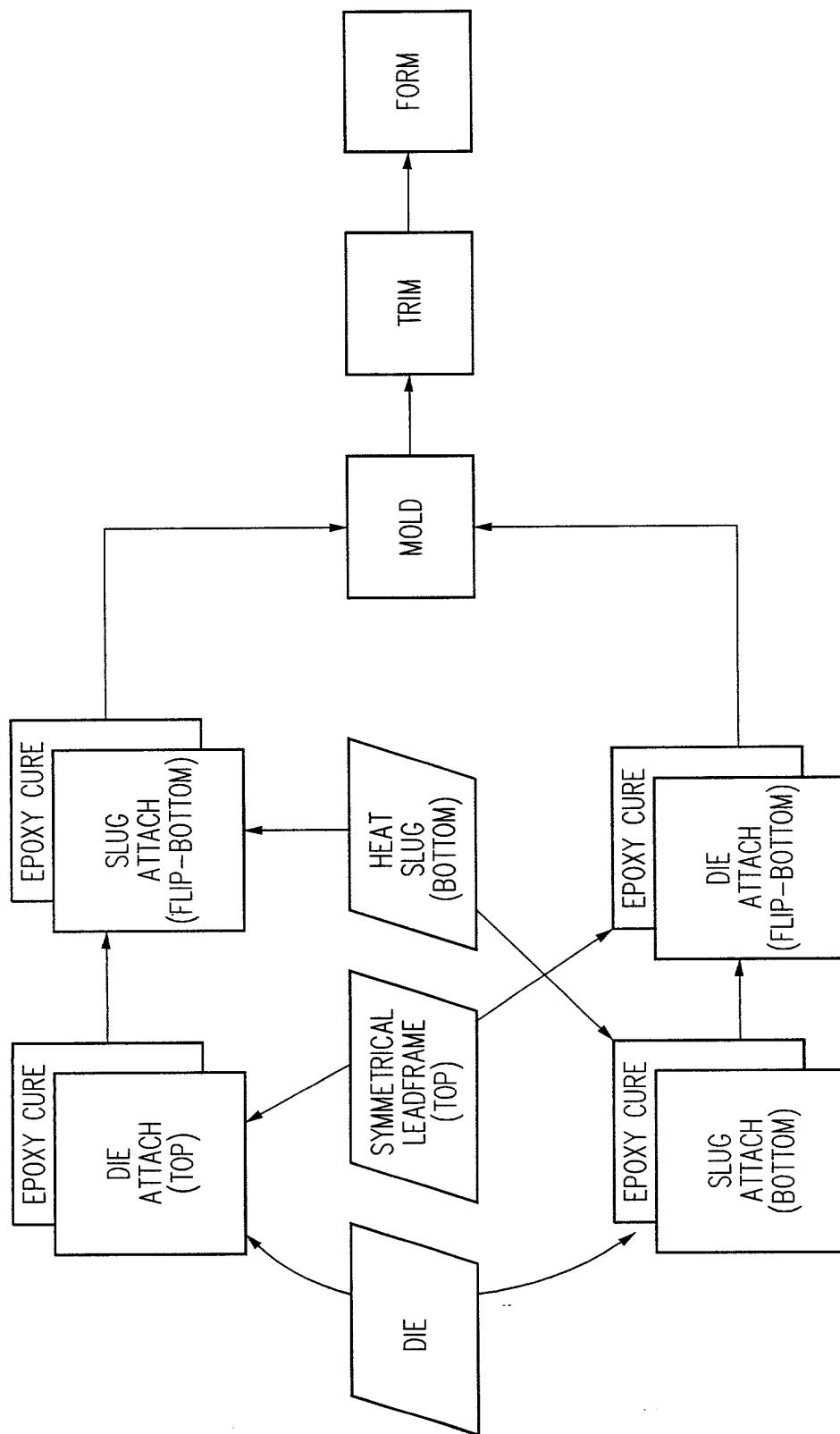
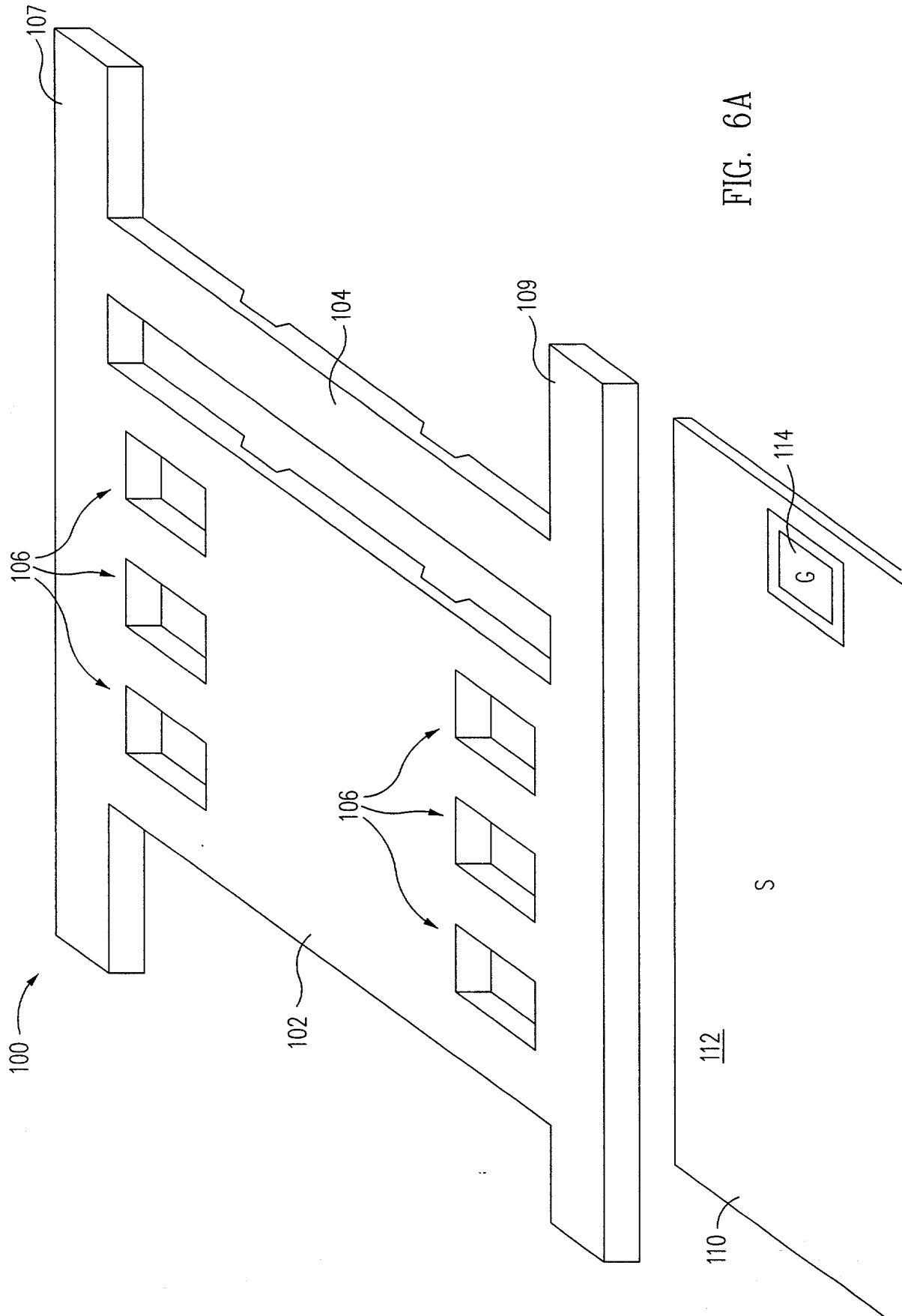
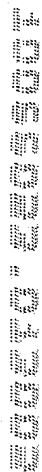


FIG. 5



[illegible]

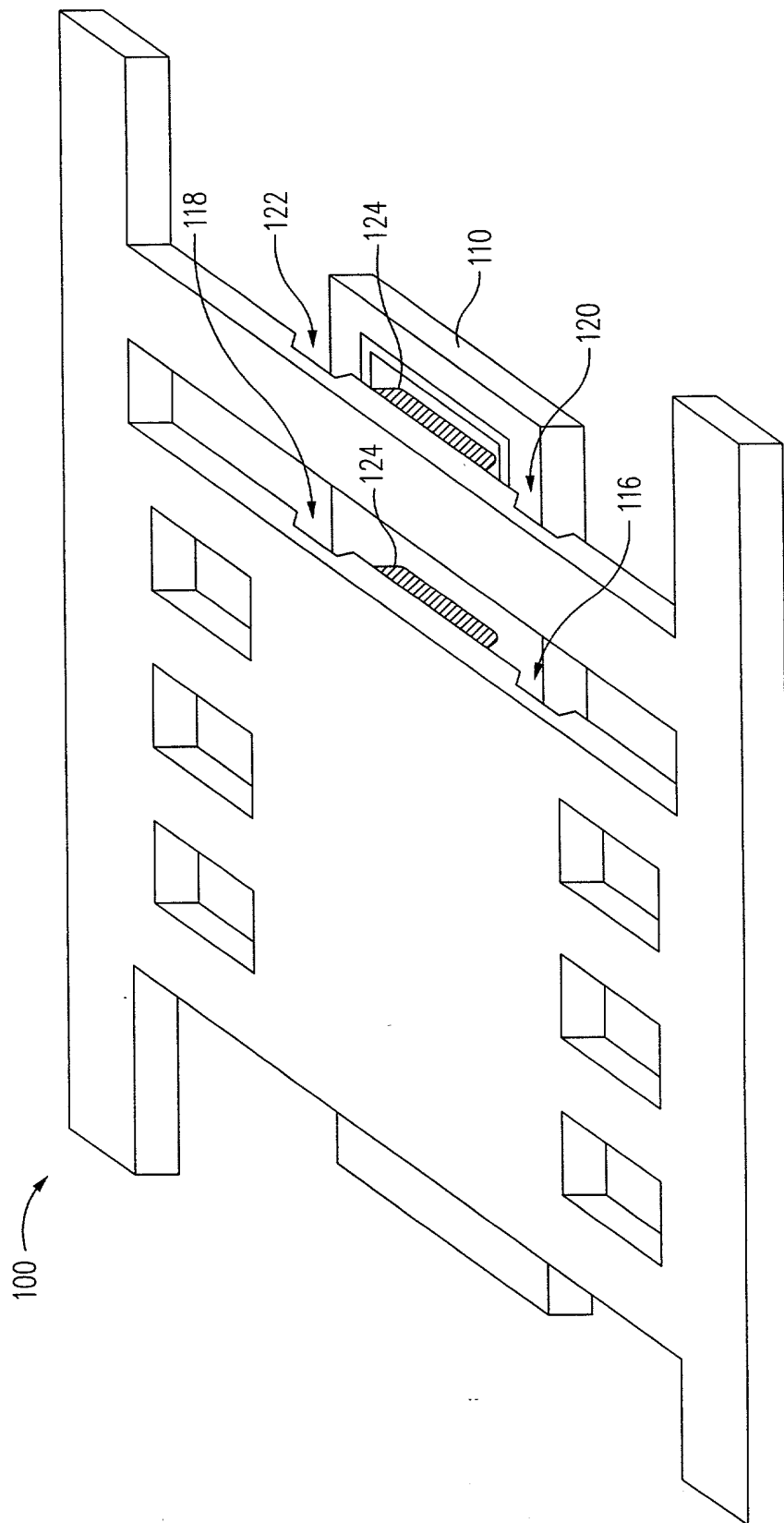


FIG. 6C

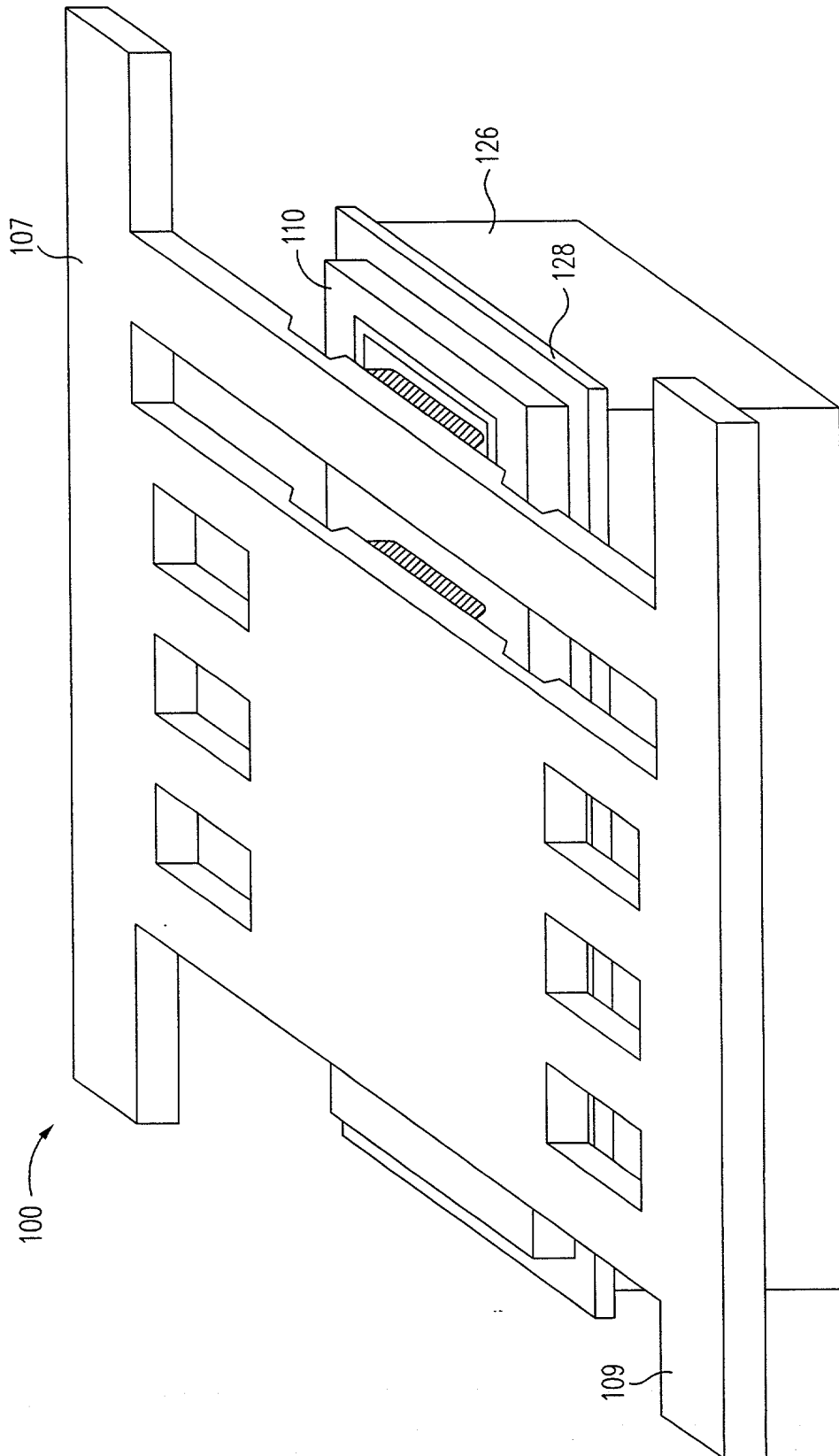


FIG. 6D

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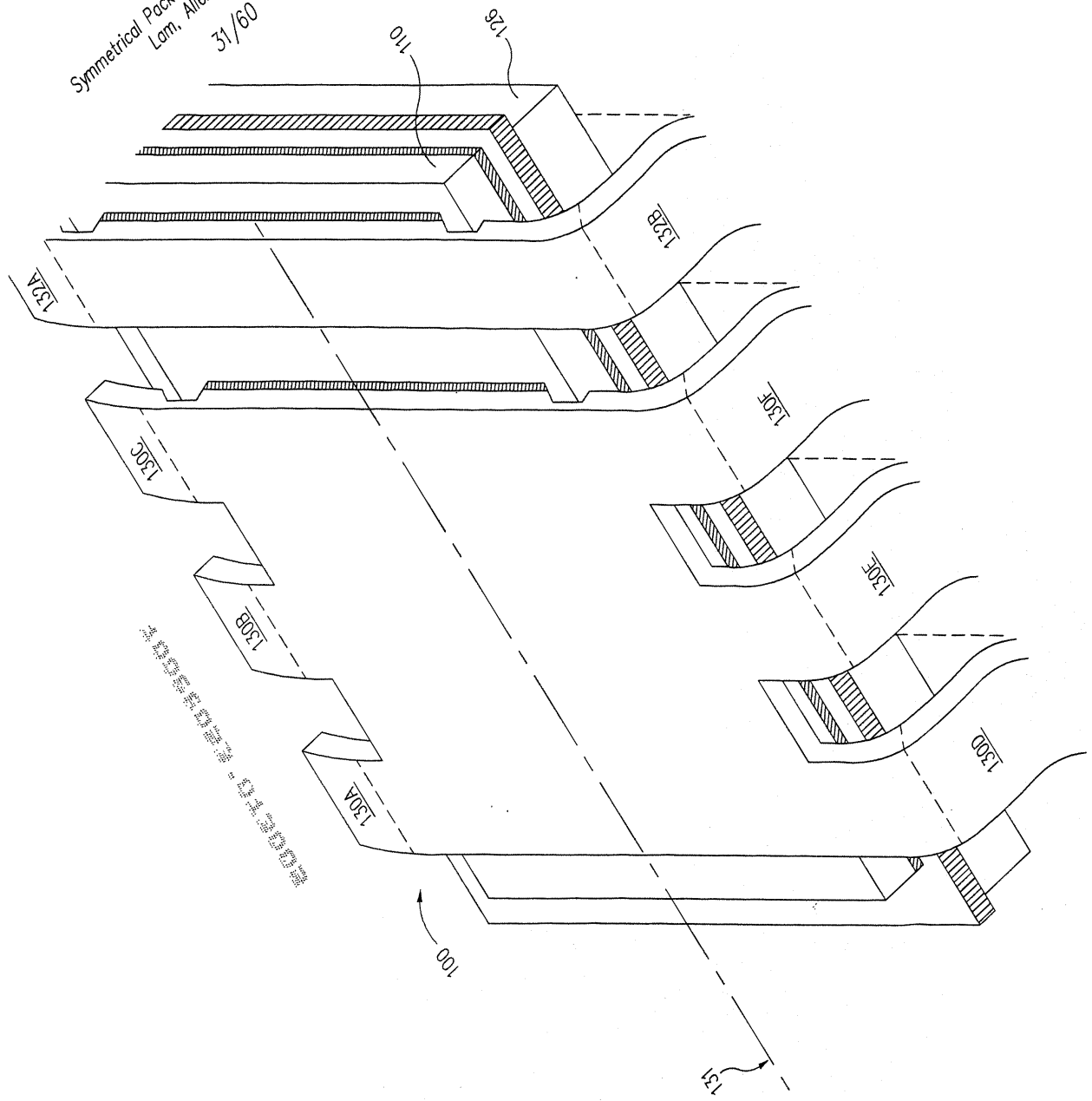


FIG. 6E

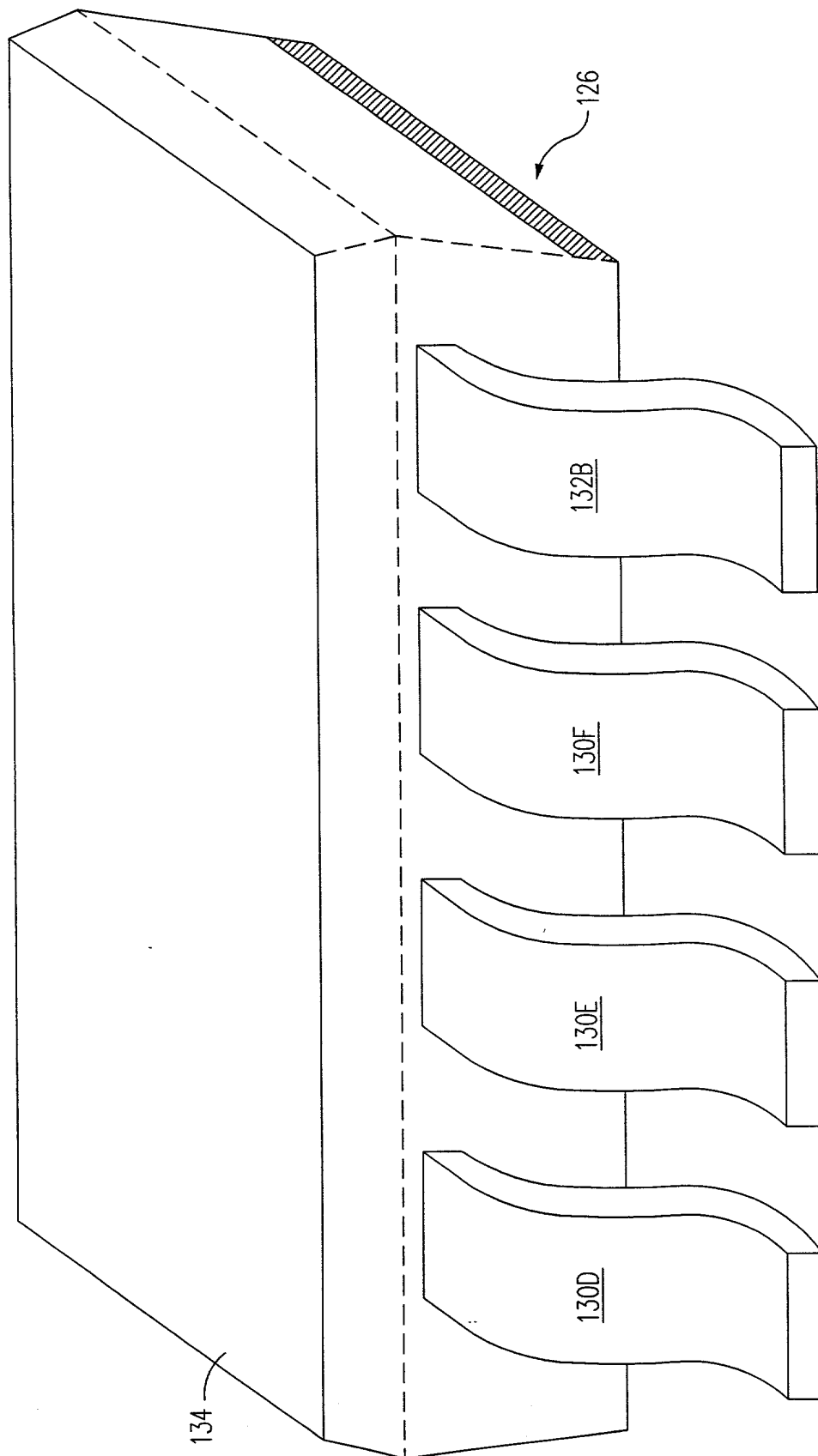


FIG. 6F

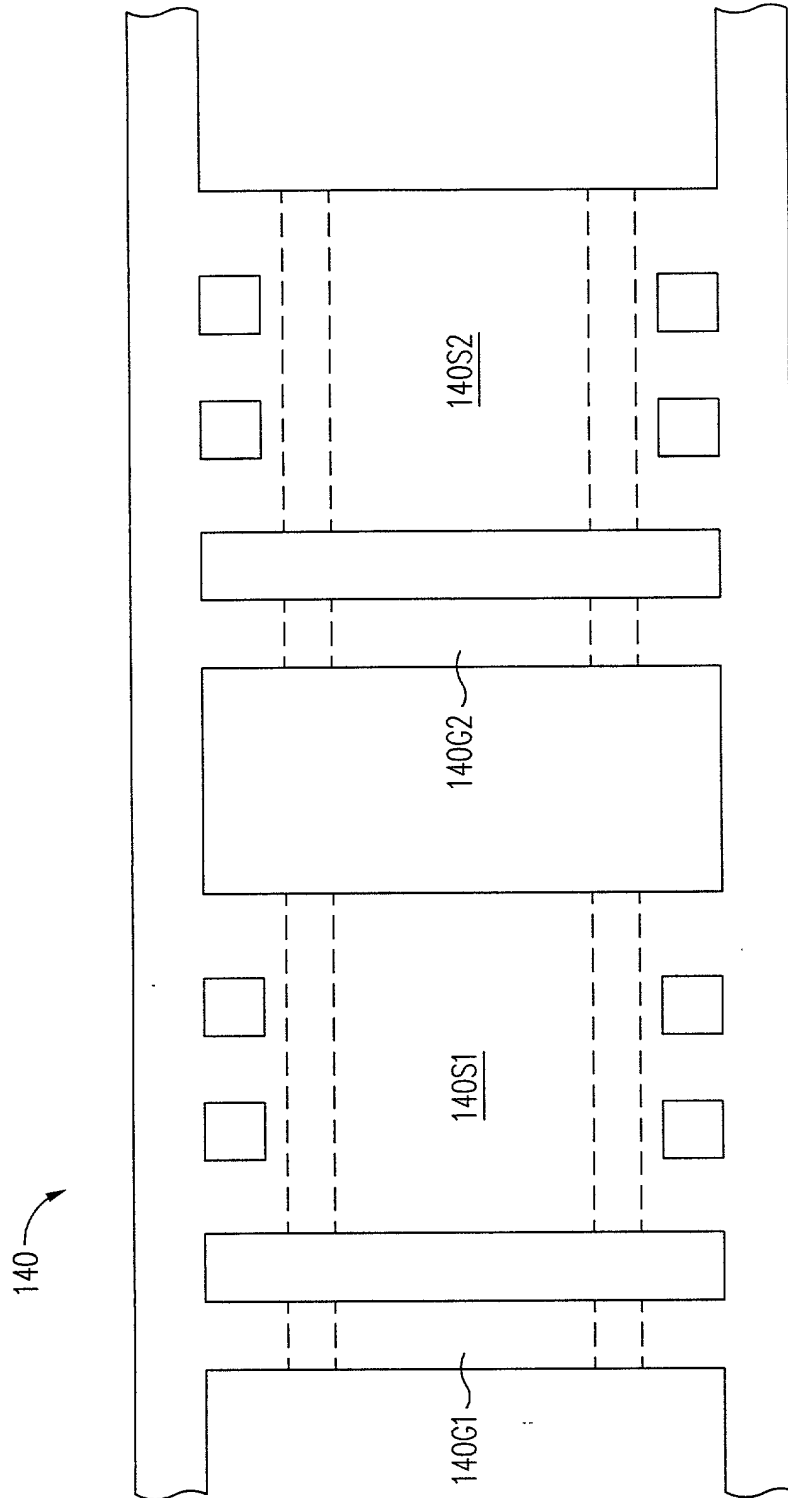


FIG. 7A

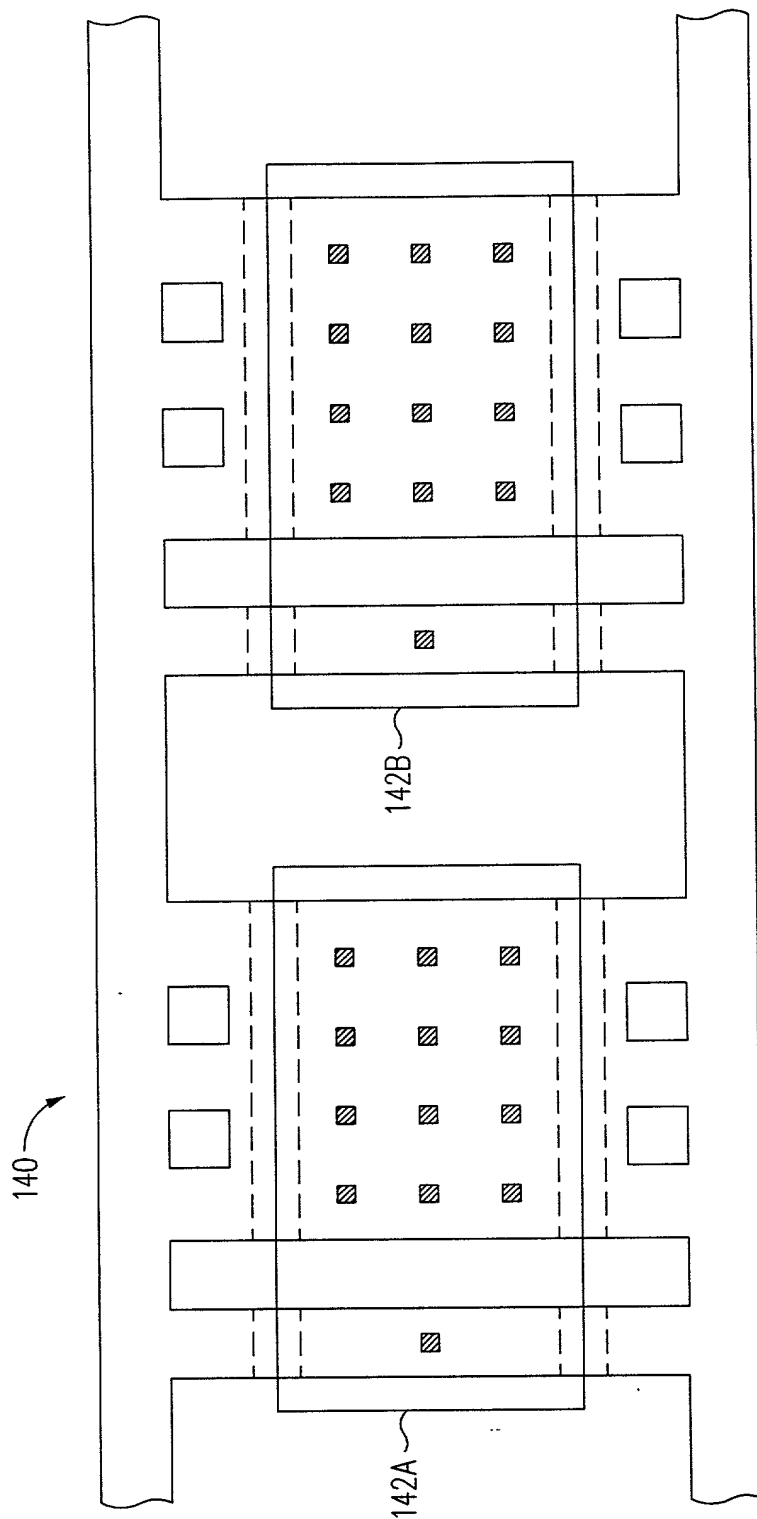


FIG. 7B

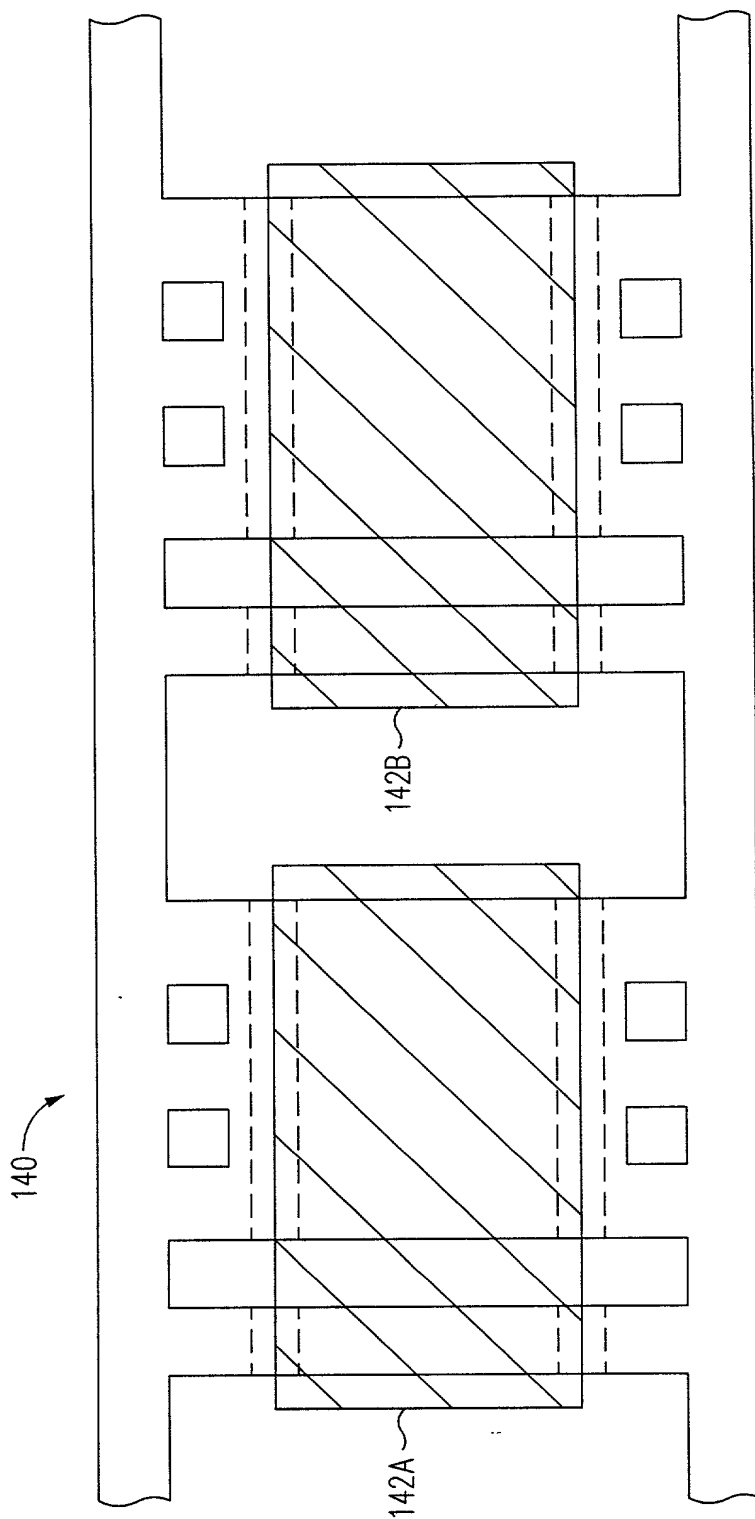


FIG. 7C

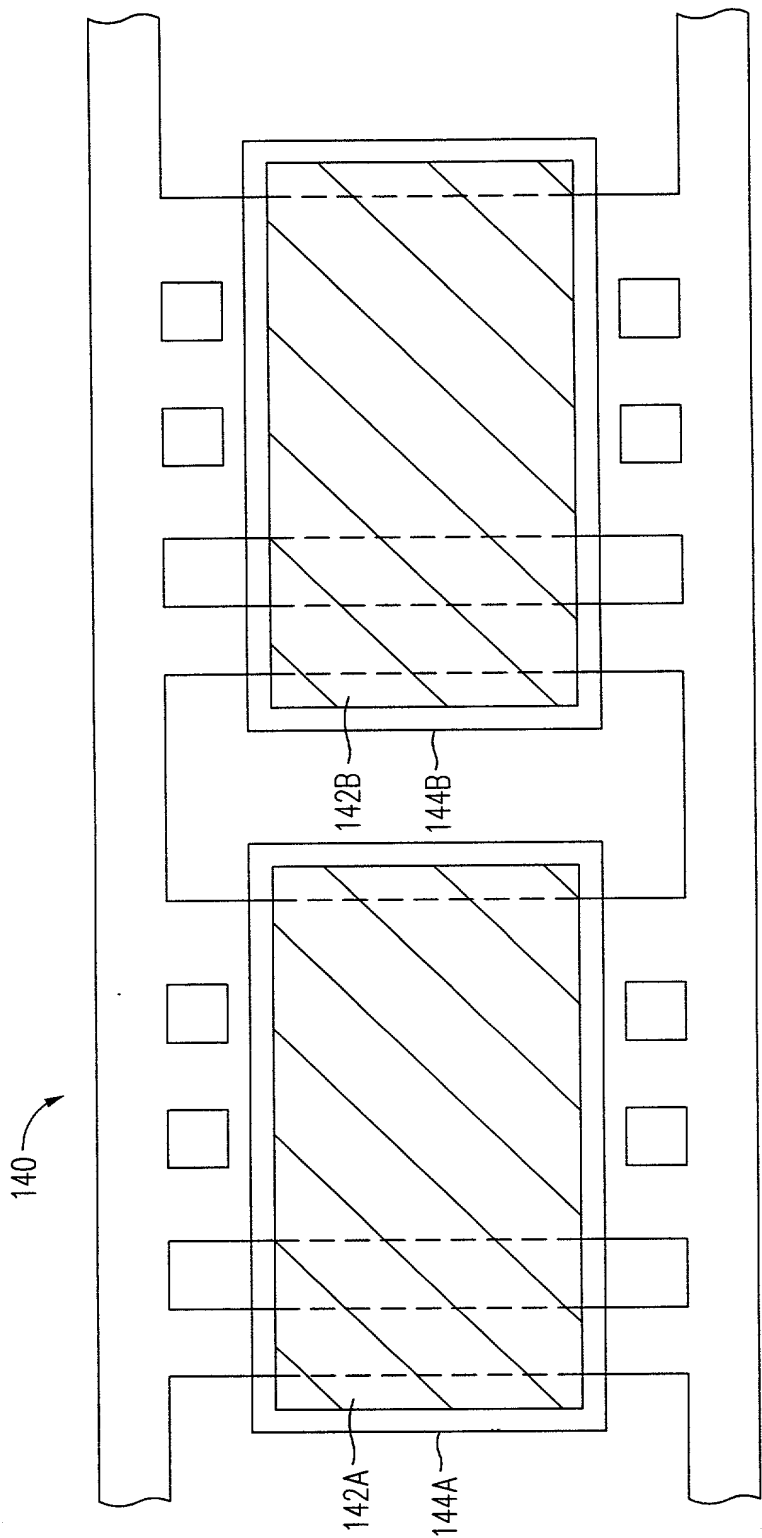


FIG. 7D

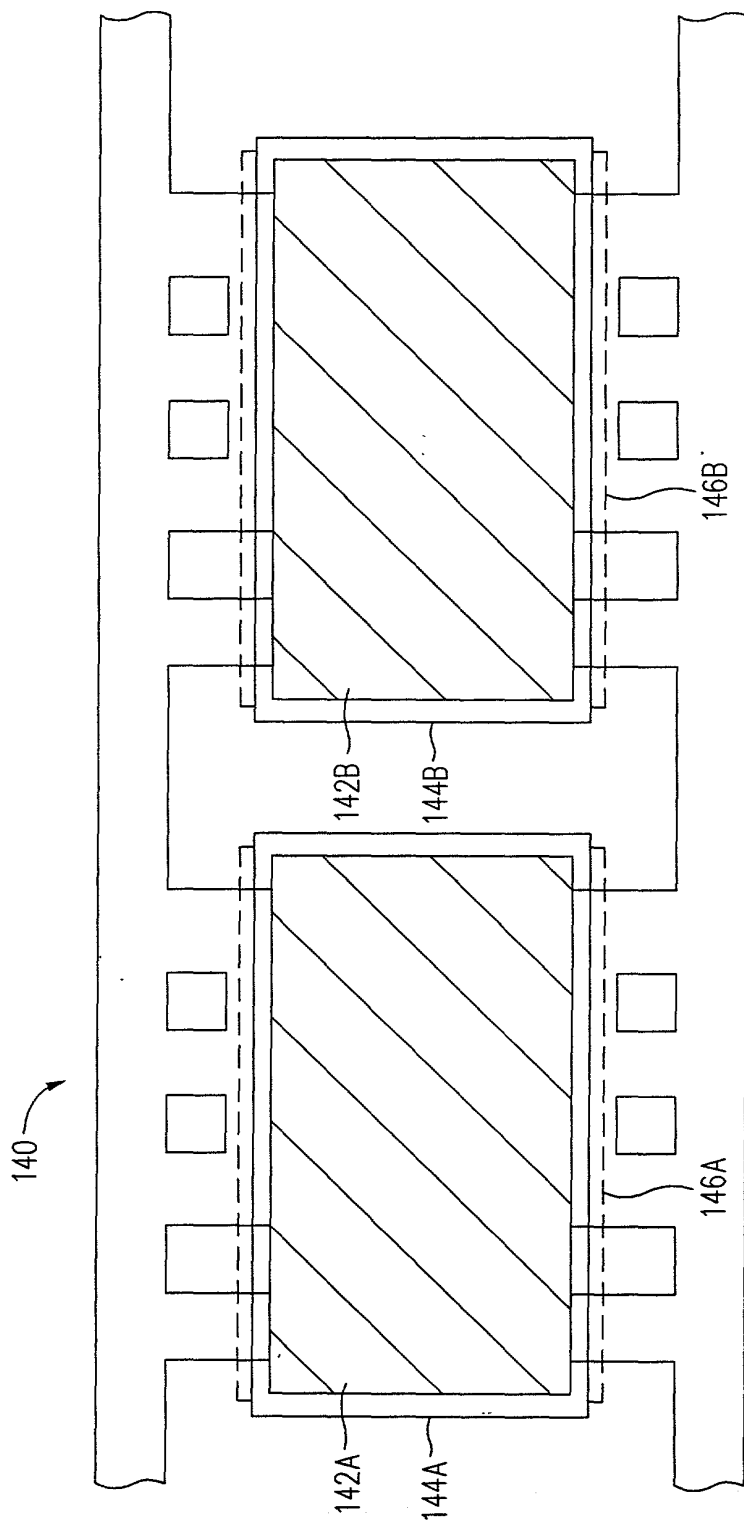


FIG. 7E

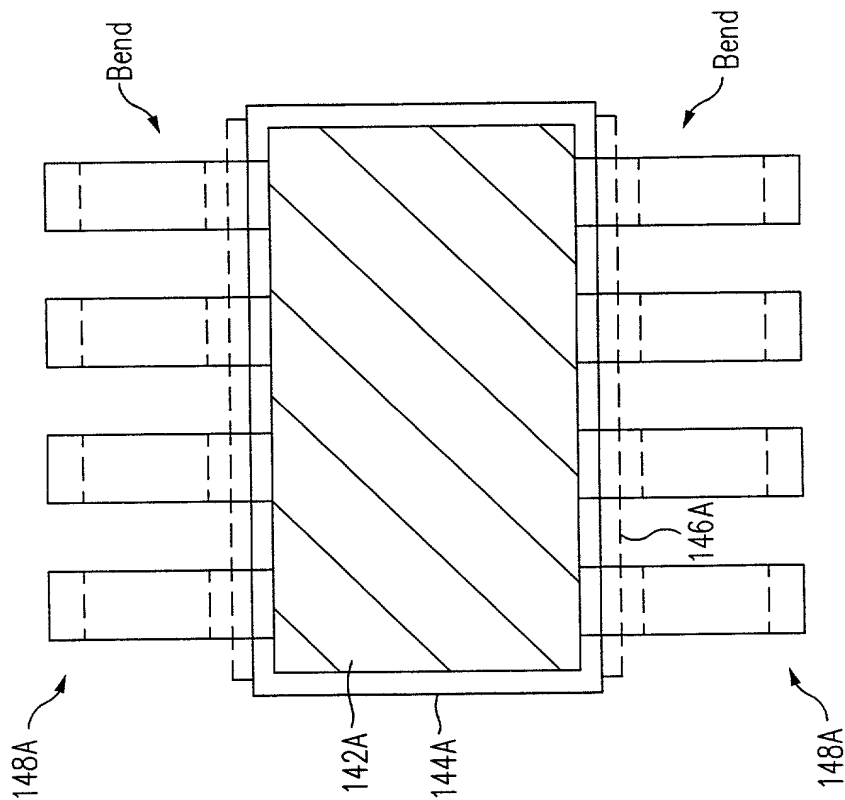


FIG. 7G

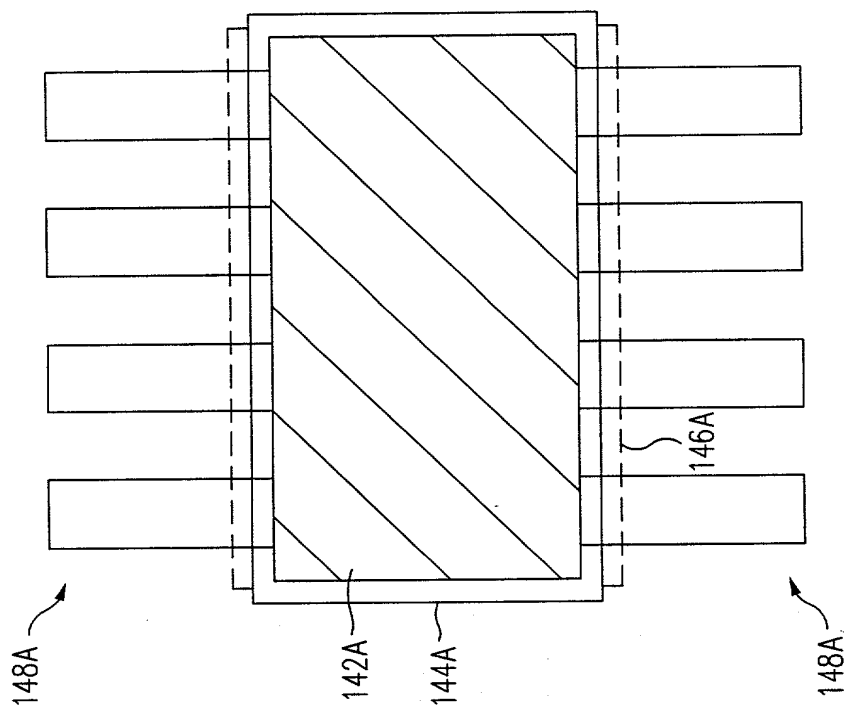


FIG. 7F

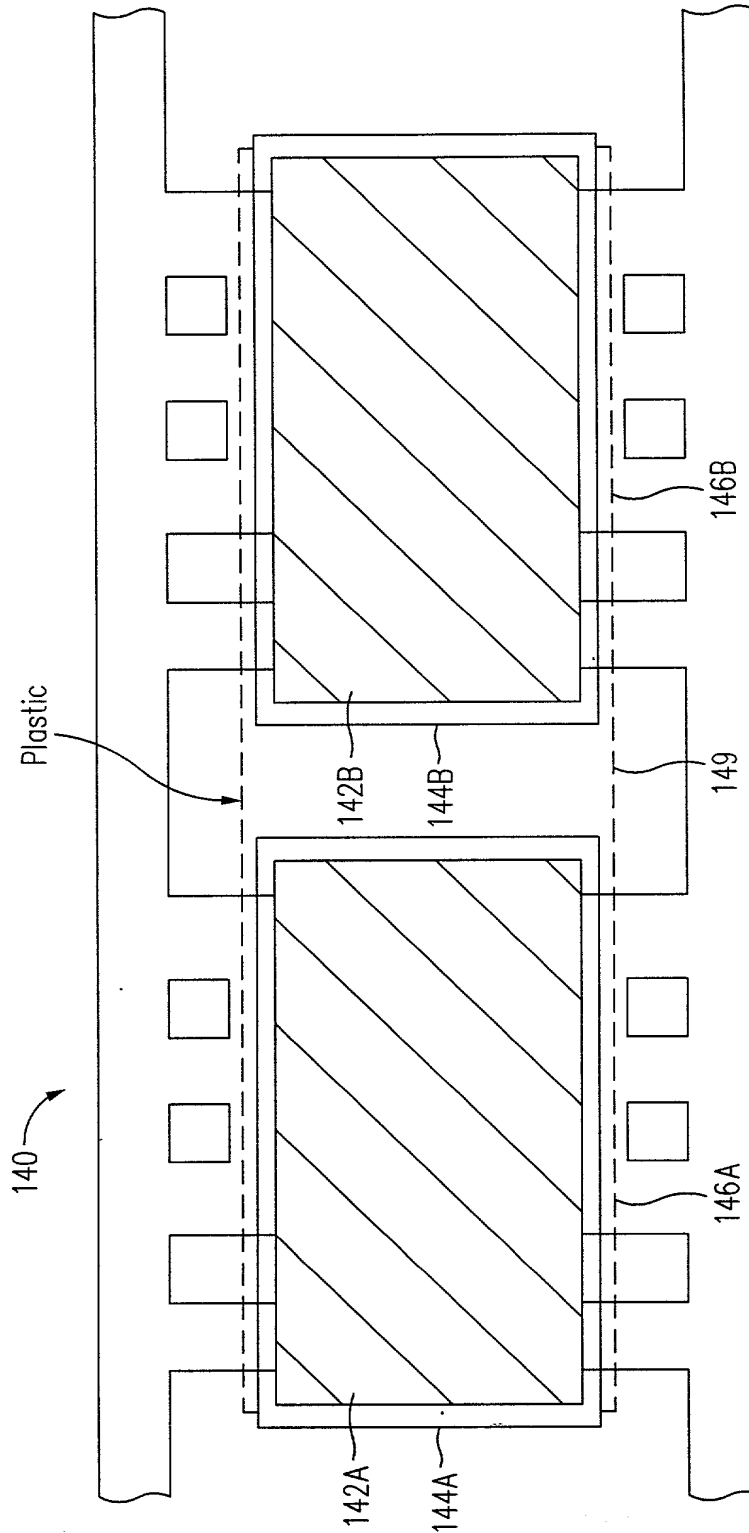


FIG. 7H

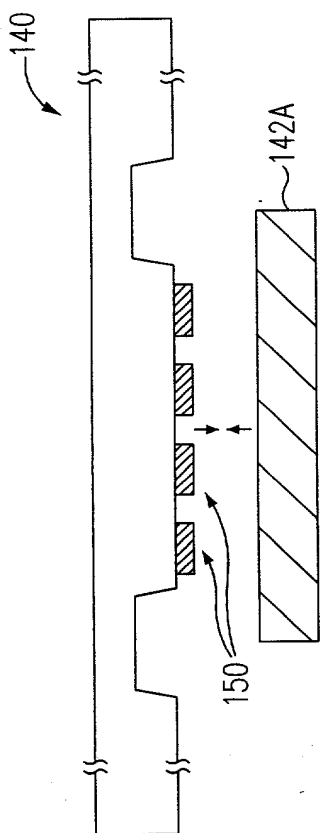


FIG. 8A

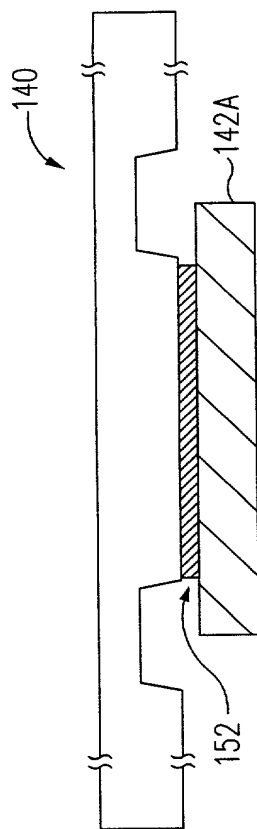


FIG. 8B

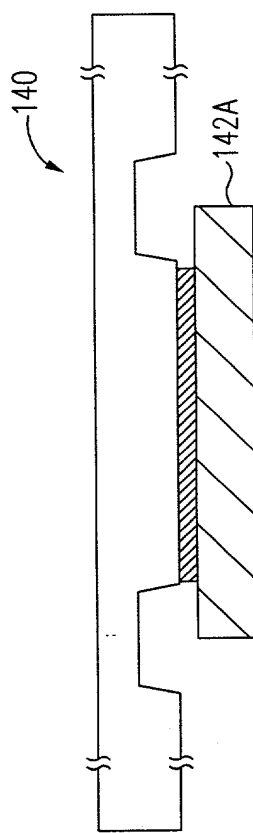


FIG. 8C

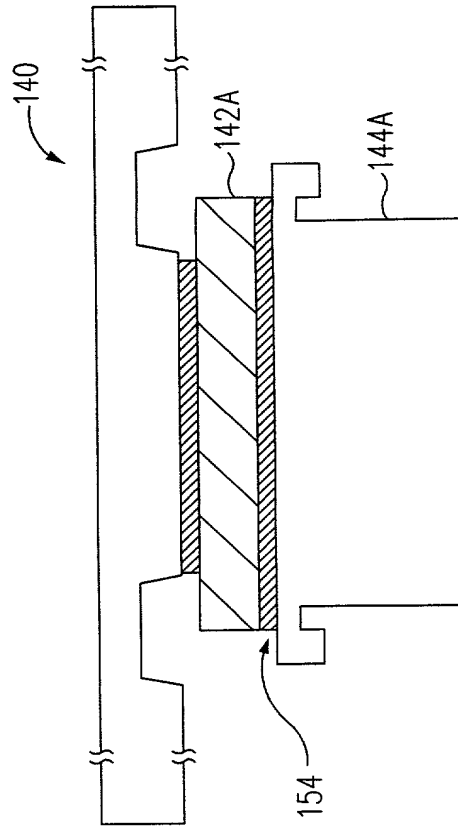


FIG. 8D

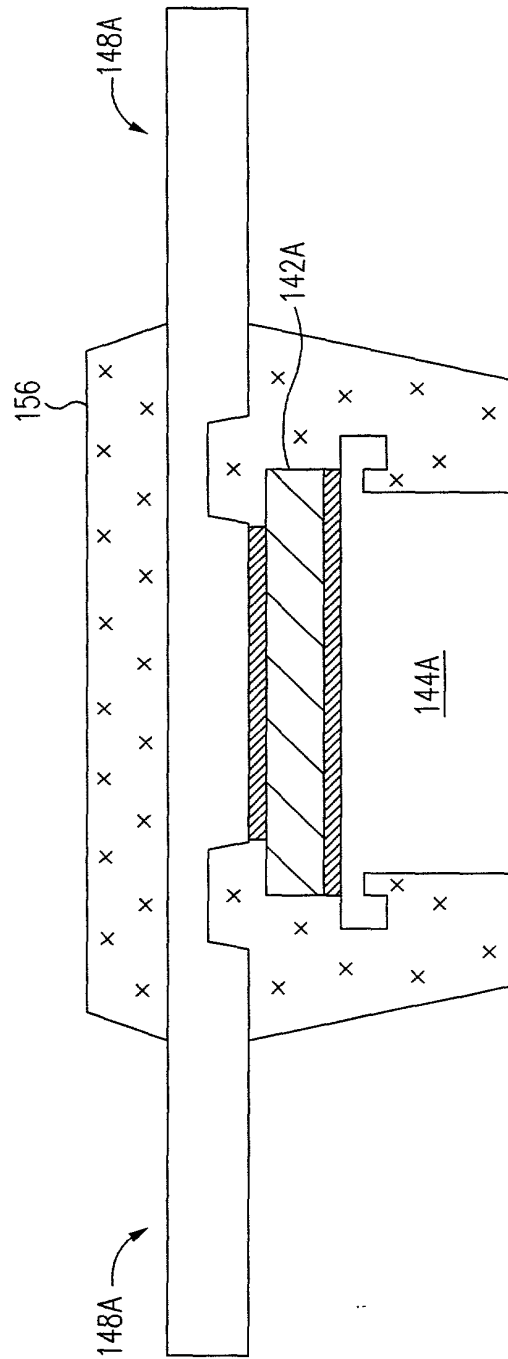


FIG. 8E

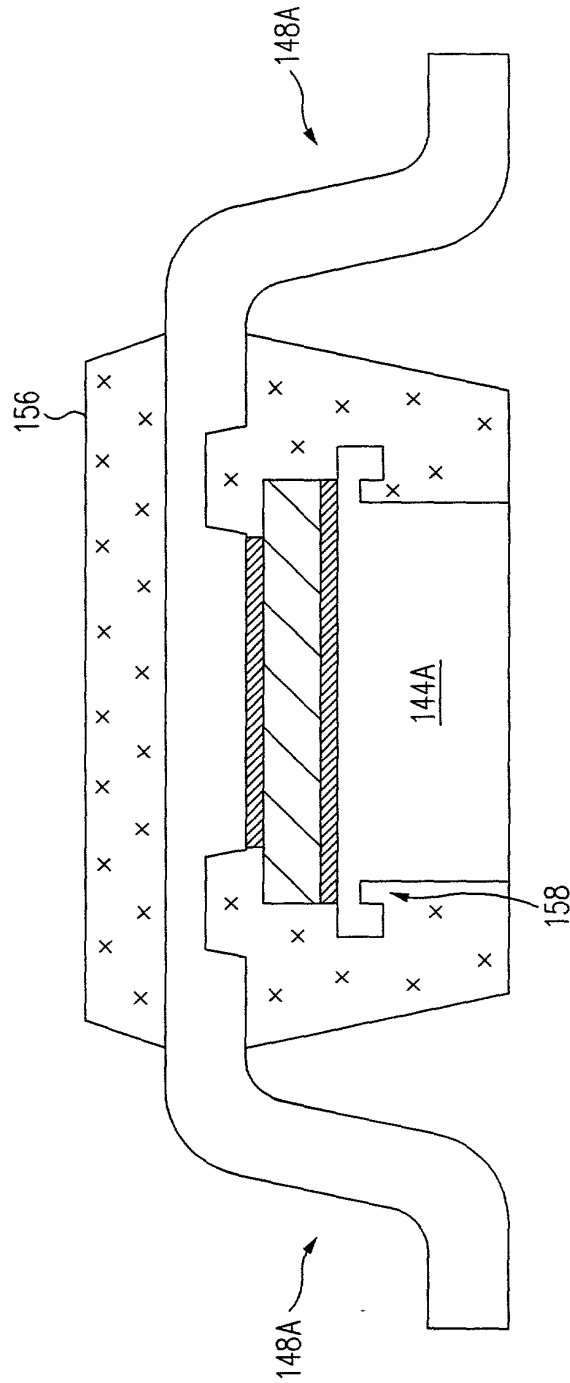


FIG. 8F

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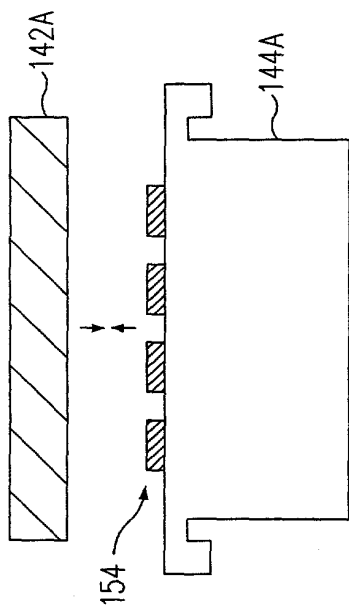


FIG. 8G

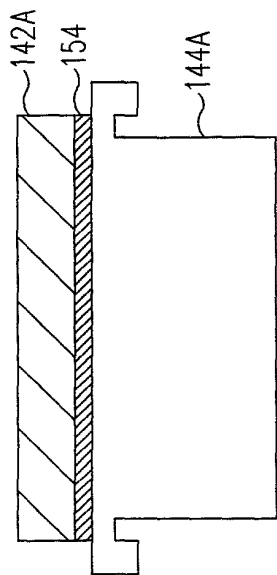


FIG. 8H

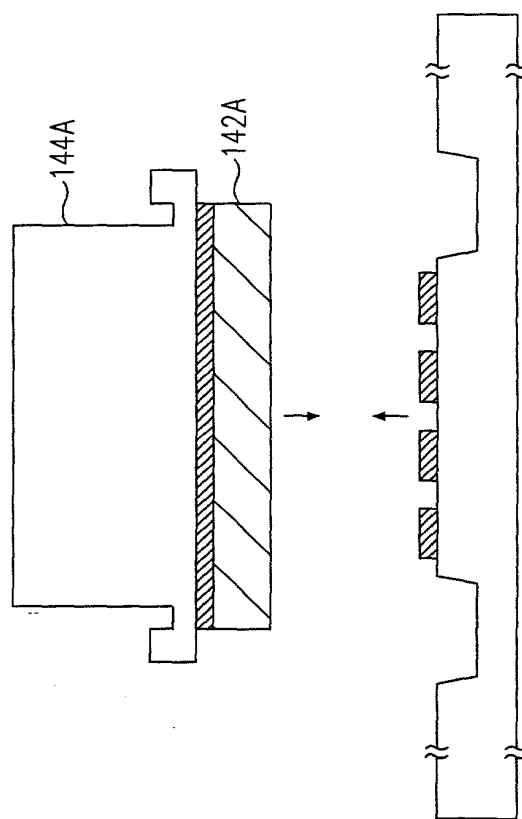


FIG. 8I

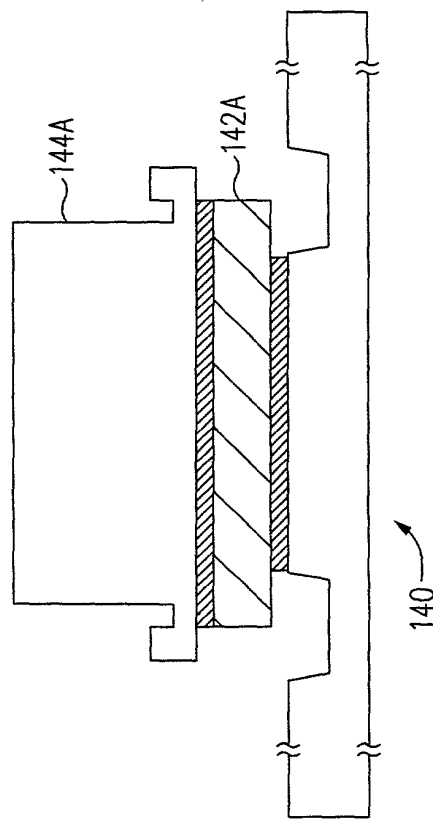
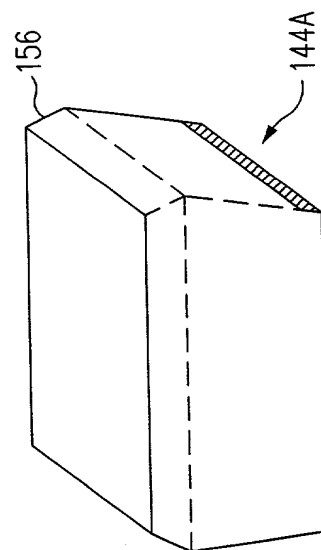
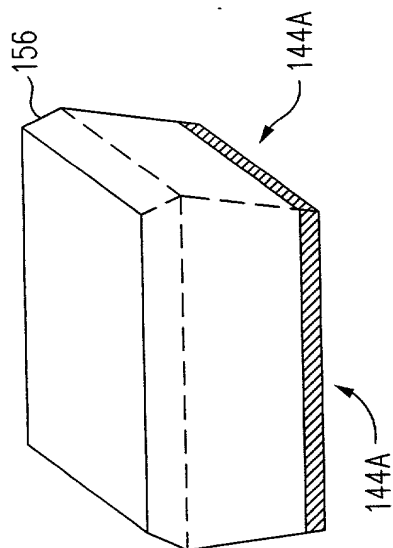
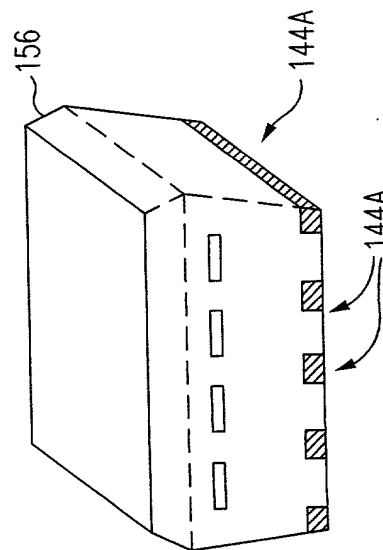
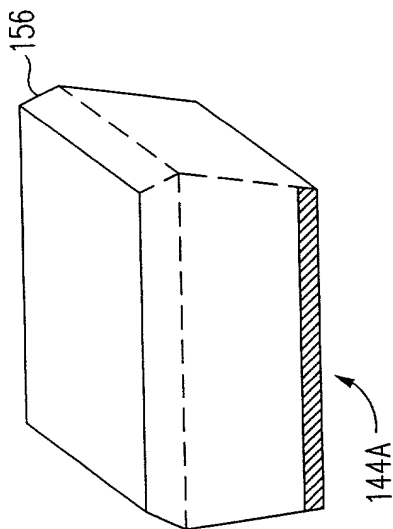


FIG. 8J



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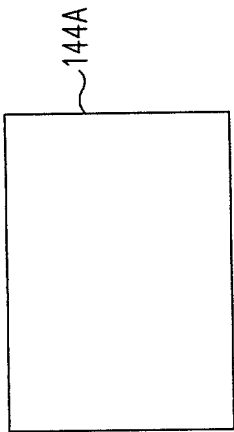


FIG. 9E

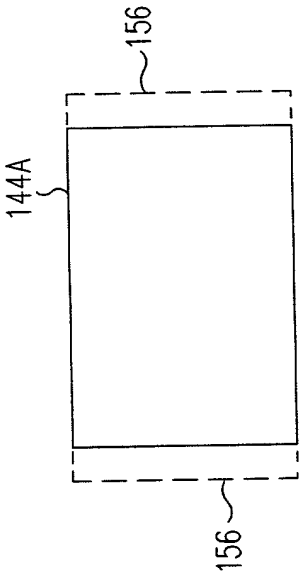


FIG. 9G

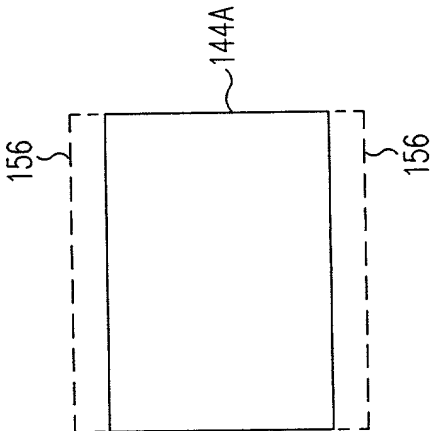


FIG. 9F

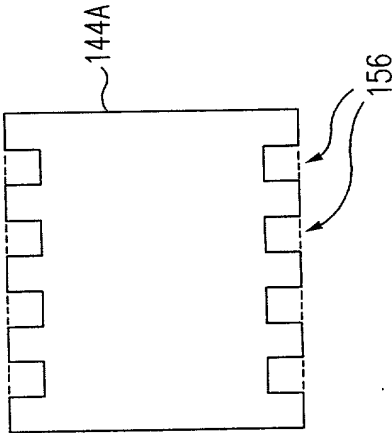


FIG. 9H

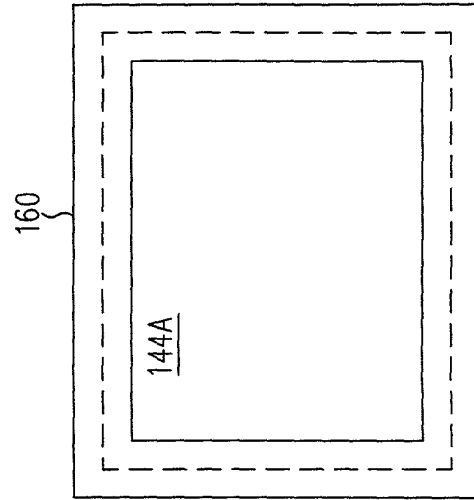


FIG. 10B

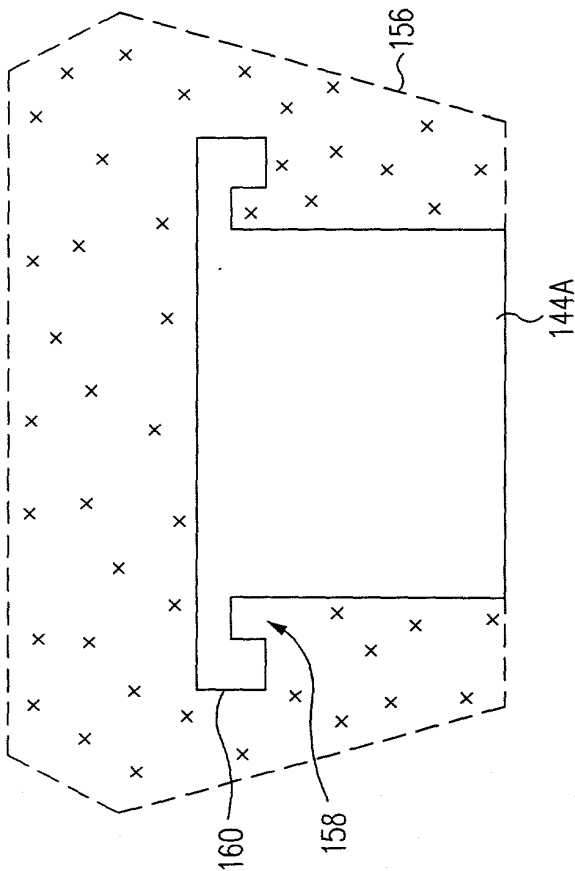


FIG. 10A

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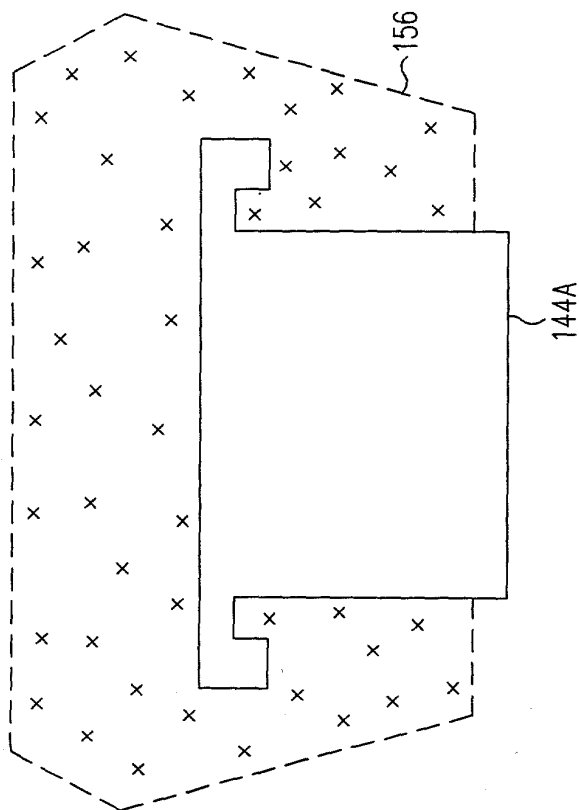


FIG. 10C

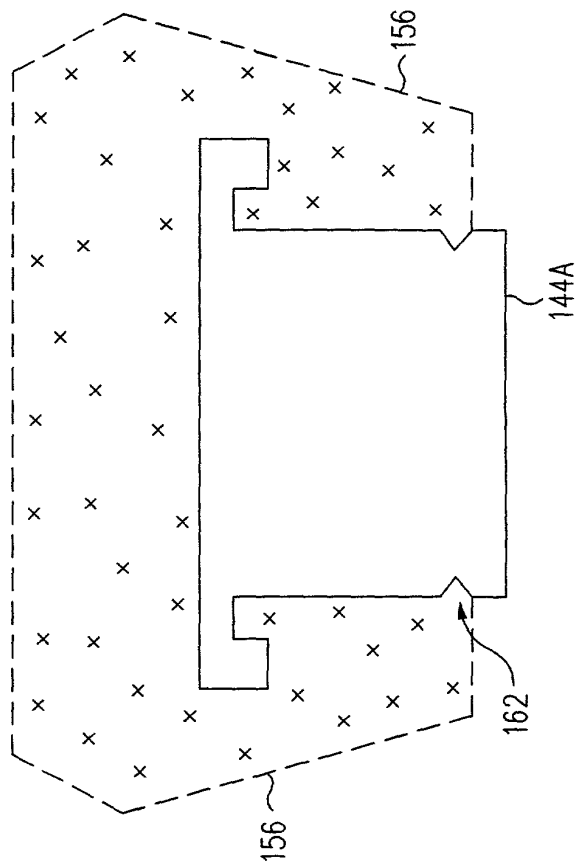


FIG. 10D

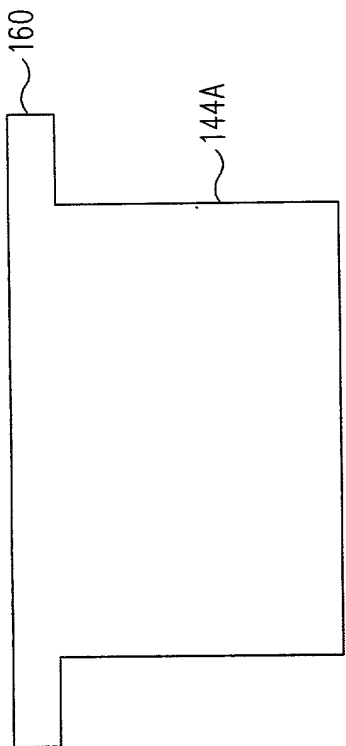


FIG. 10E

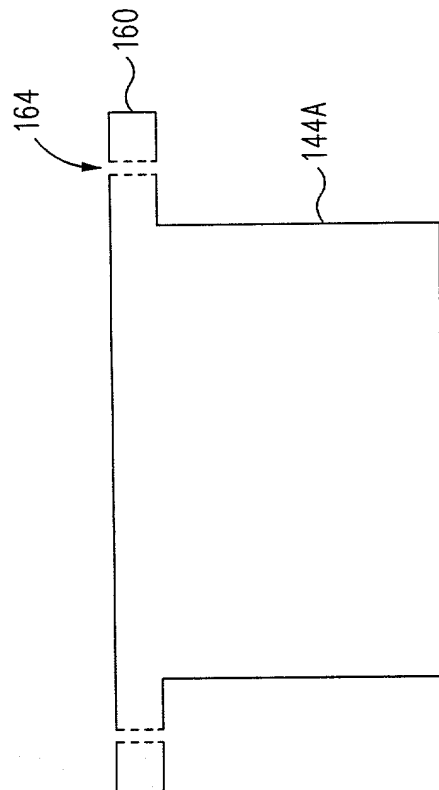


FIG. 10F

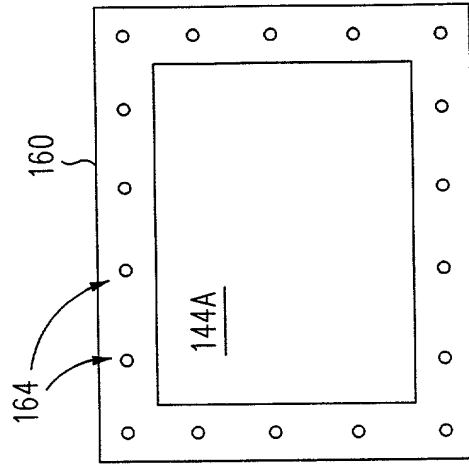


FIG. 10G

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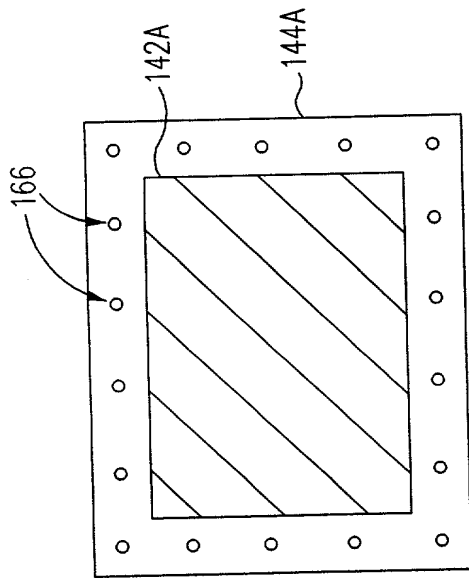


FIG. 10I

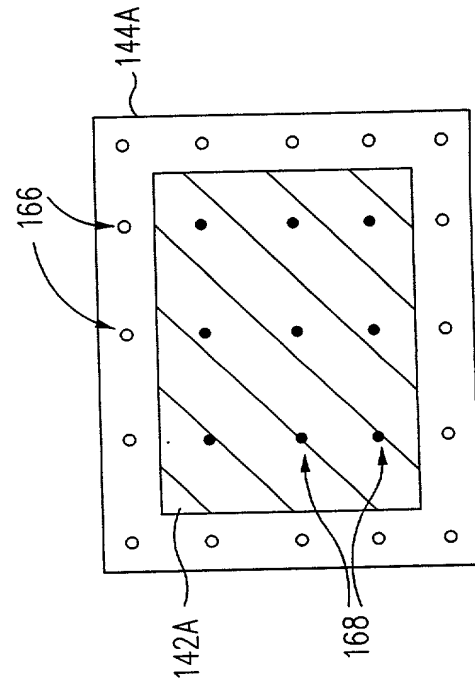


FIG. 10K

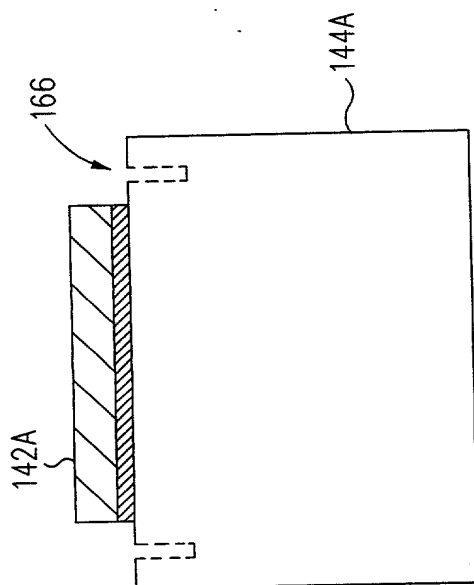


FIG. 10H

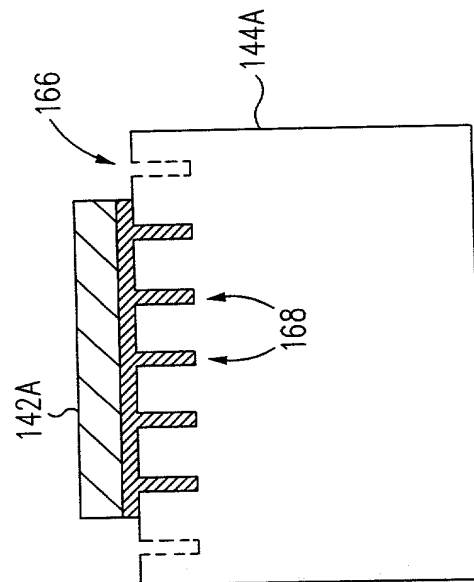
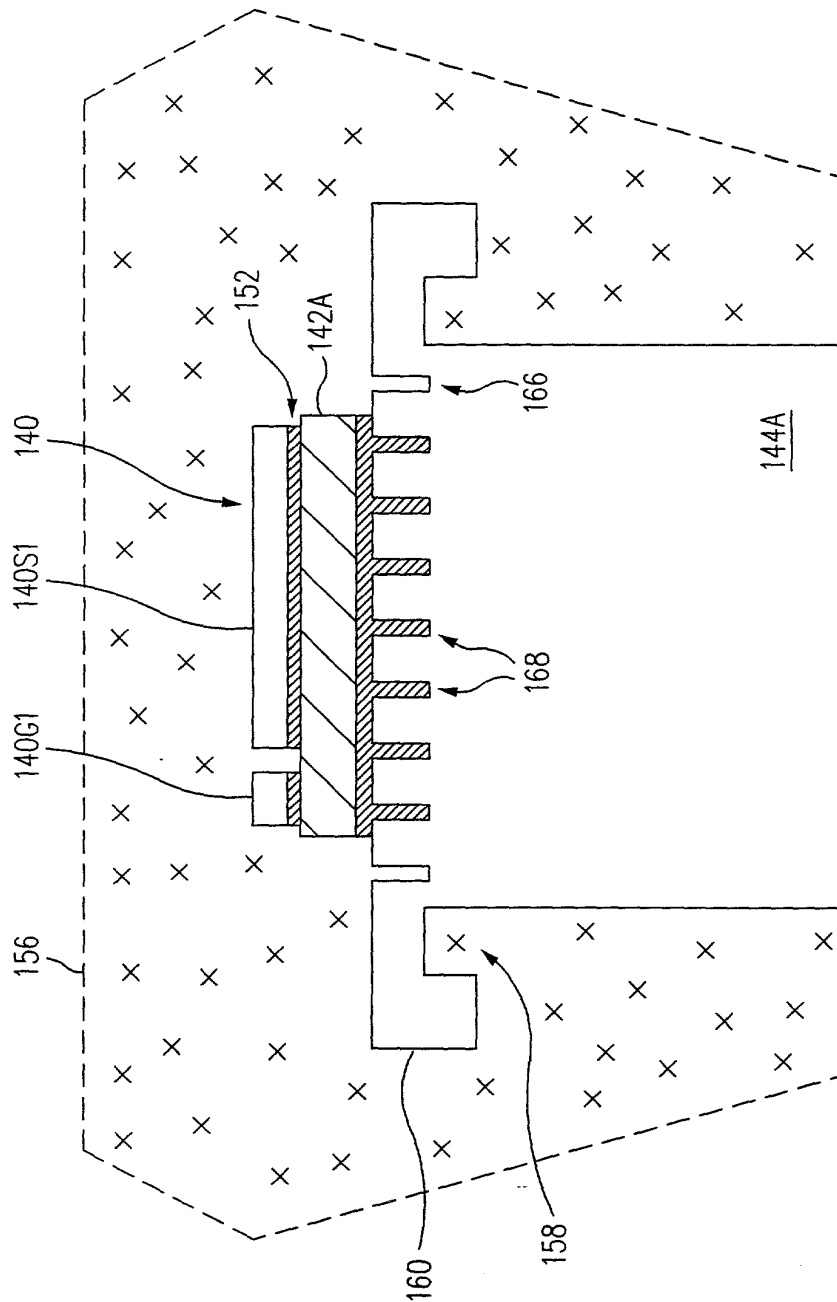


FIG. 10J



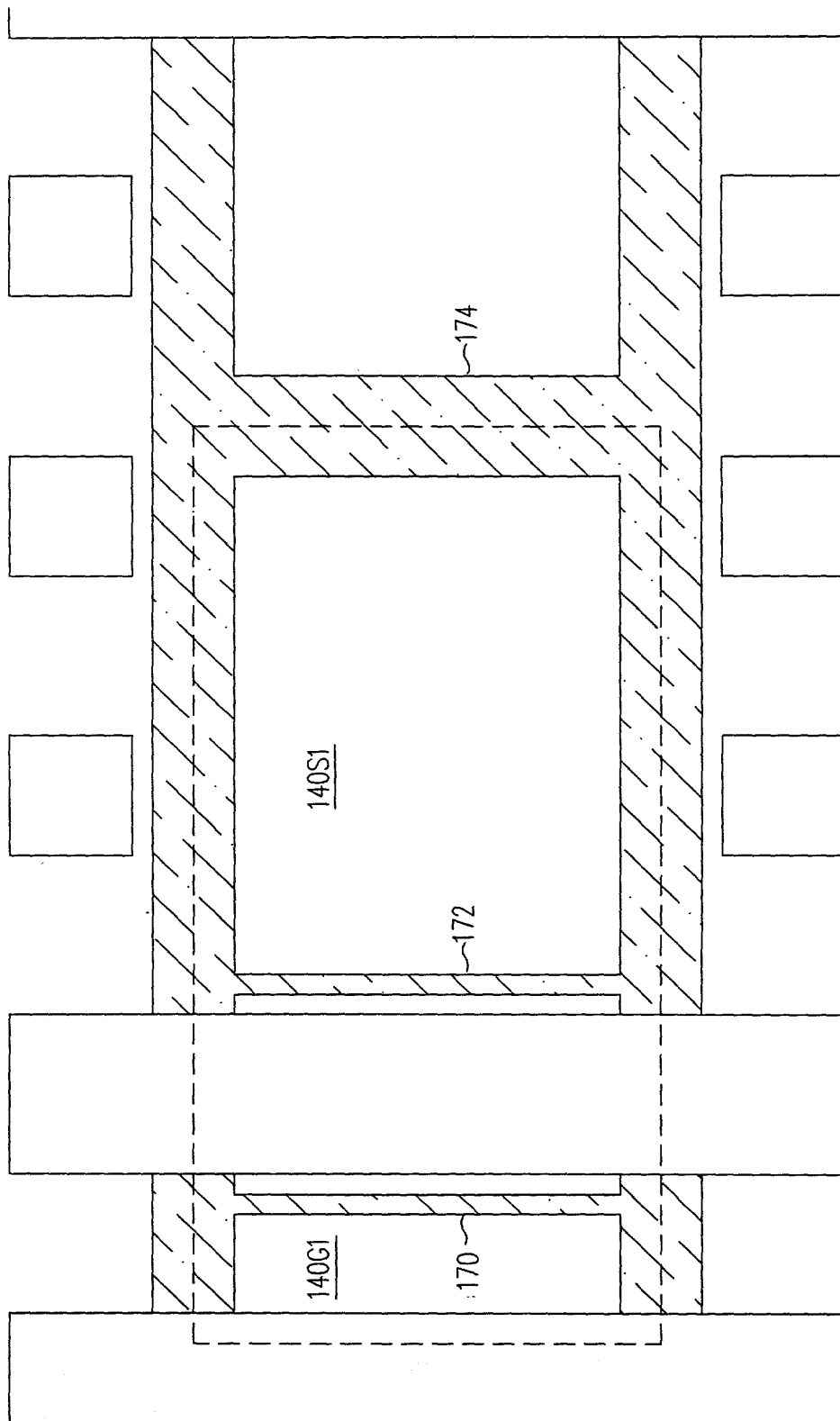
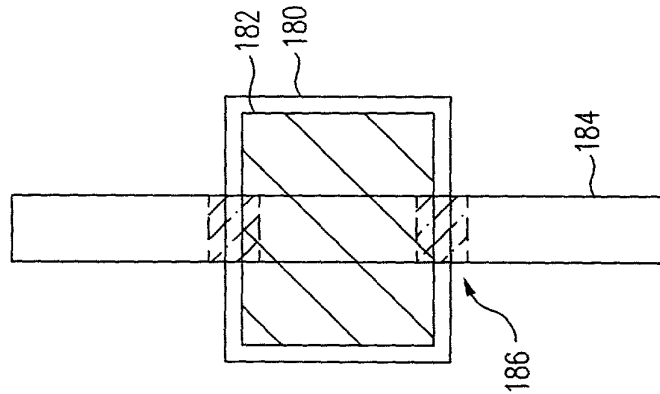
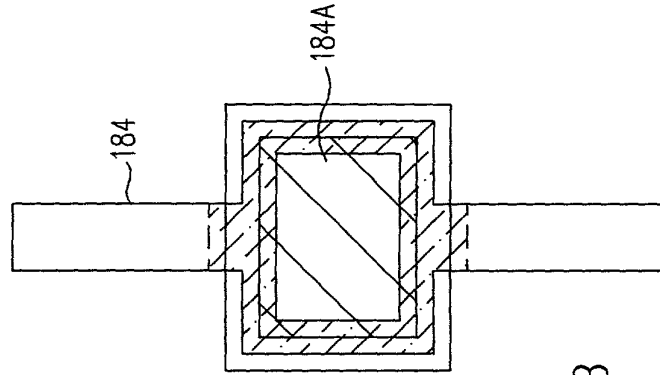
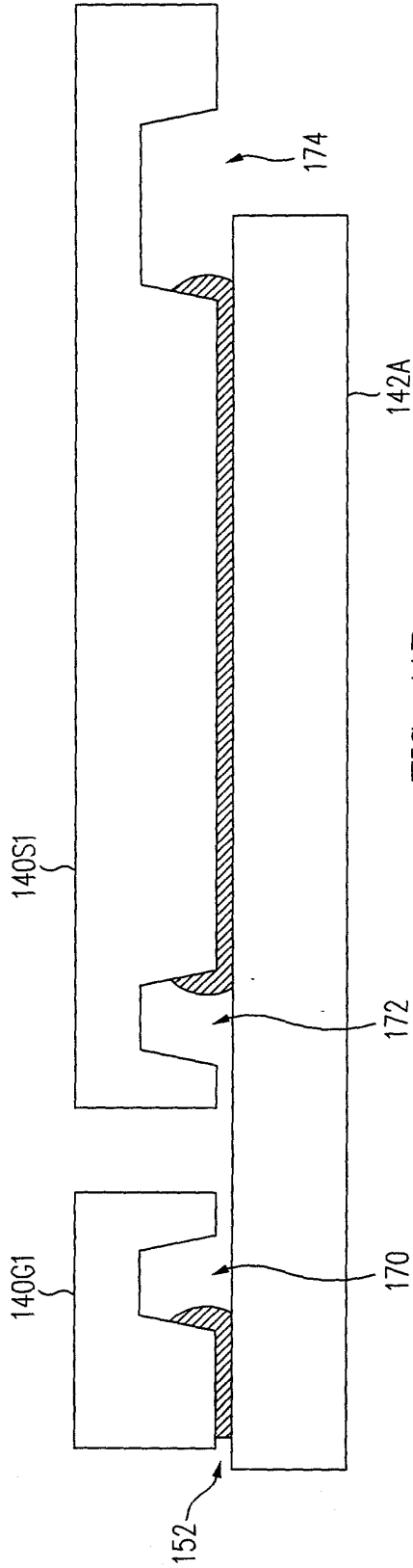


FIG. 11A

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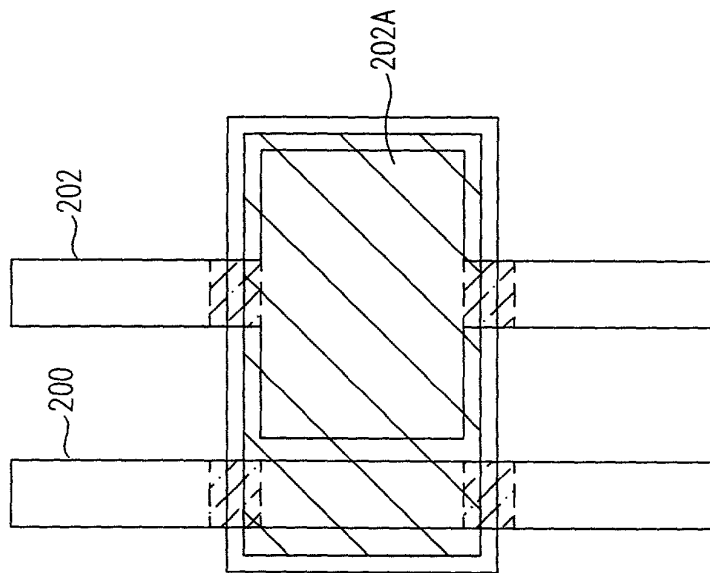


FIG. 12D

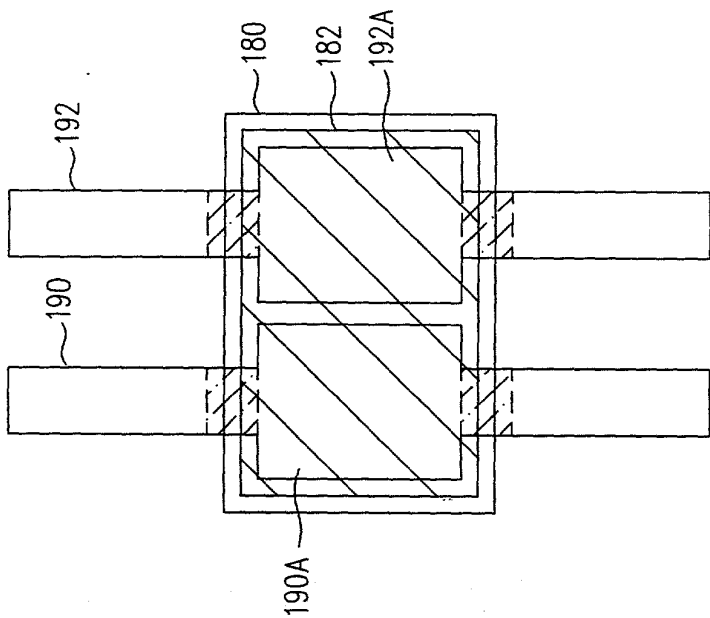


FIG. 12C

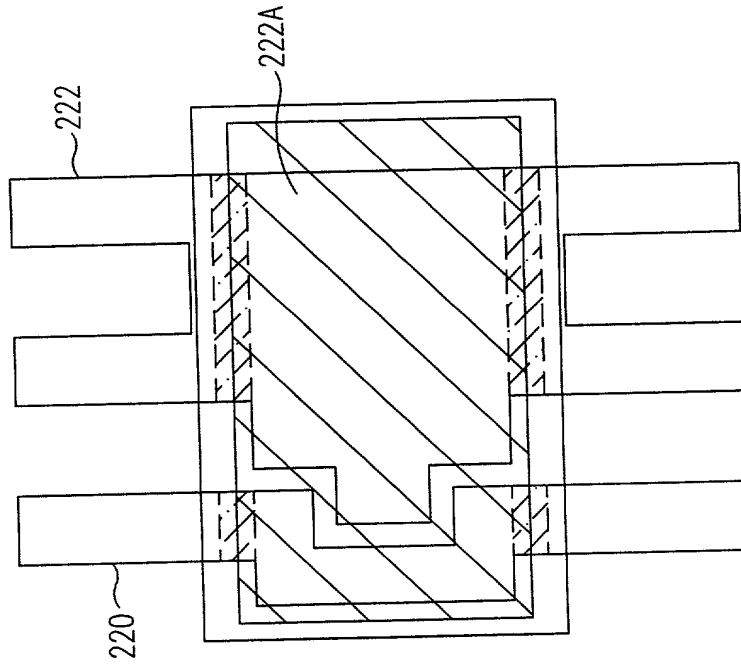


FIG. 12F

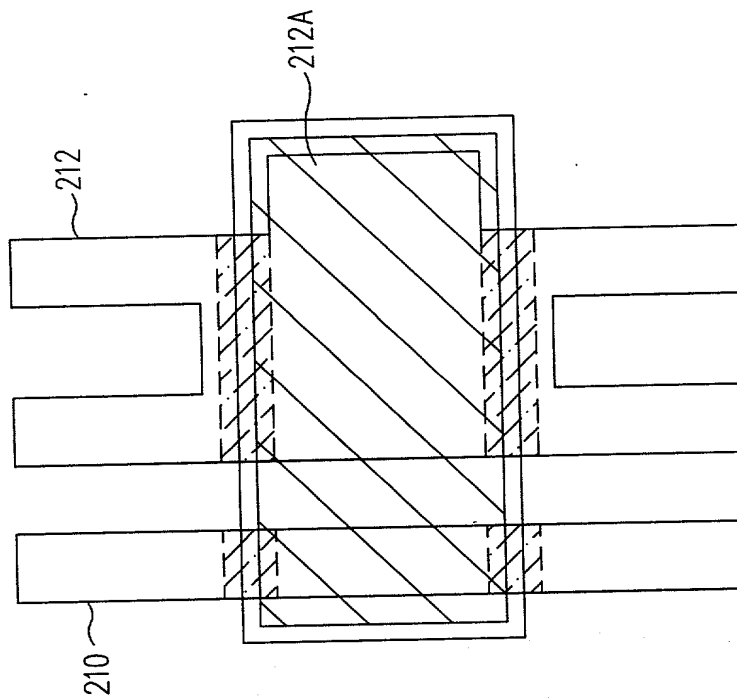


FIG. 12E

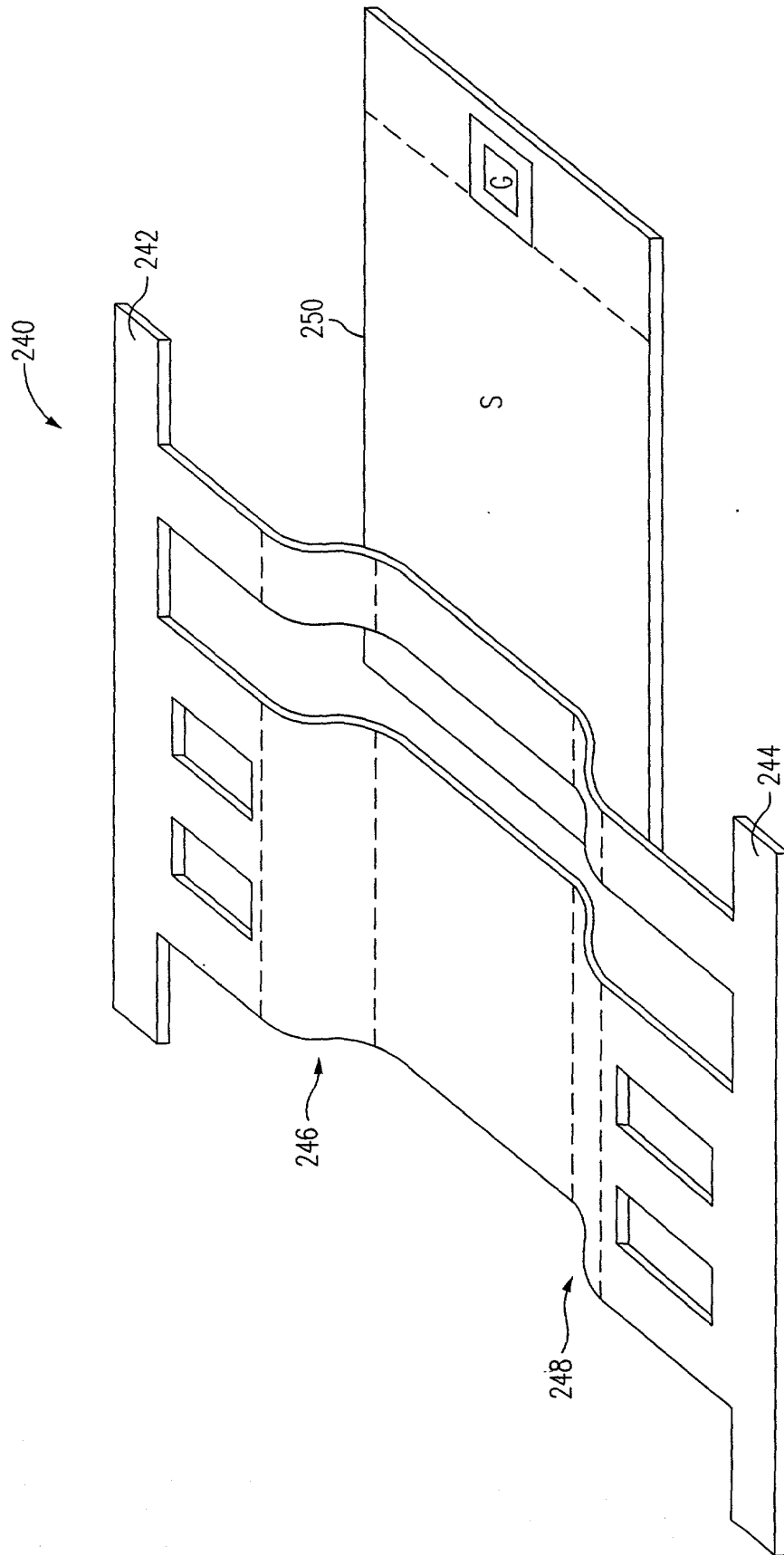


FIG. 13A

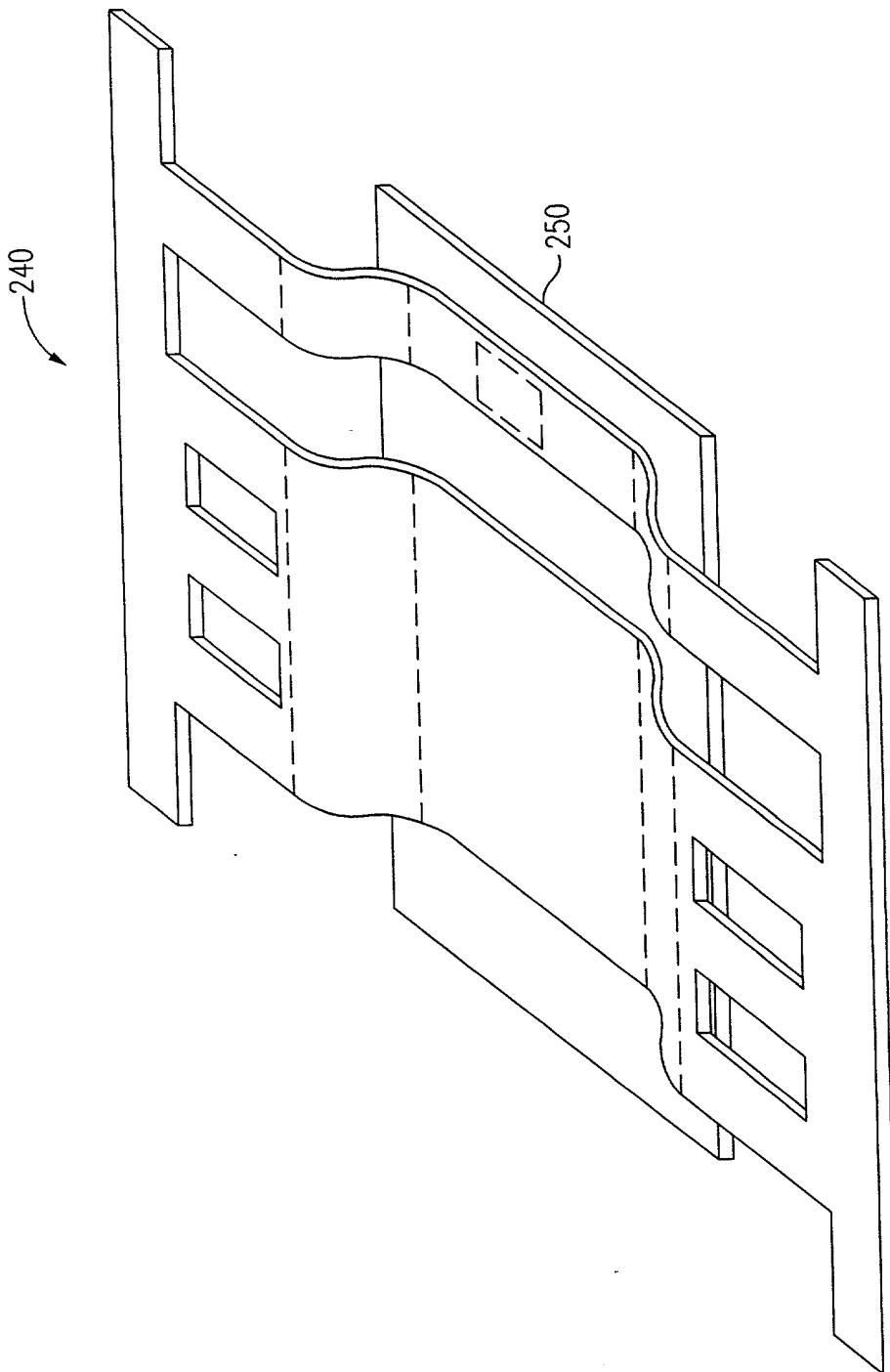


FIG. 13B

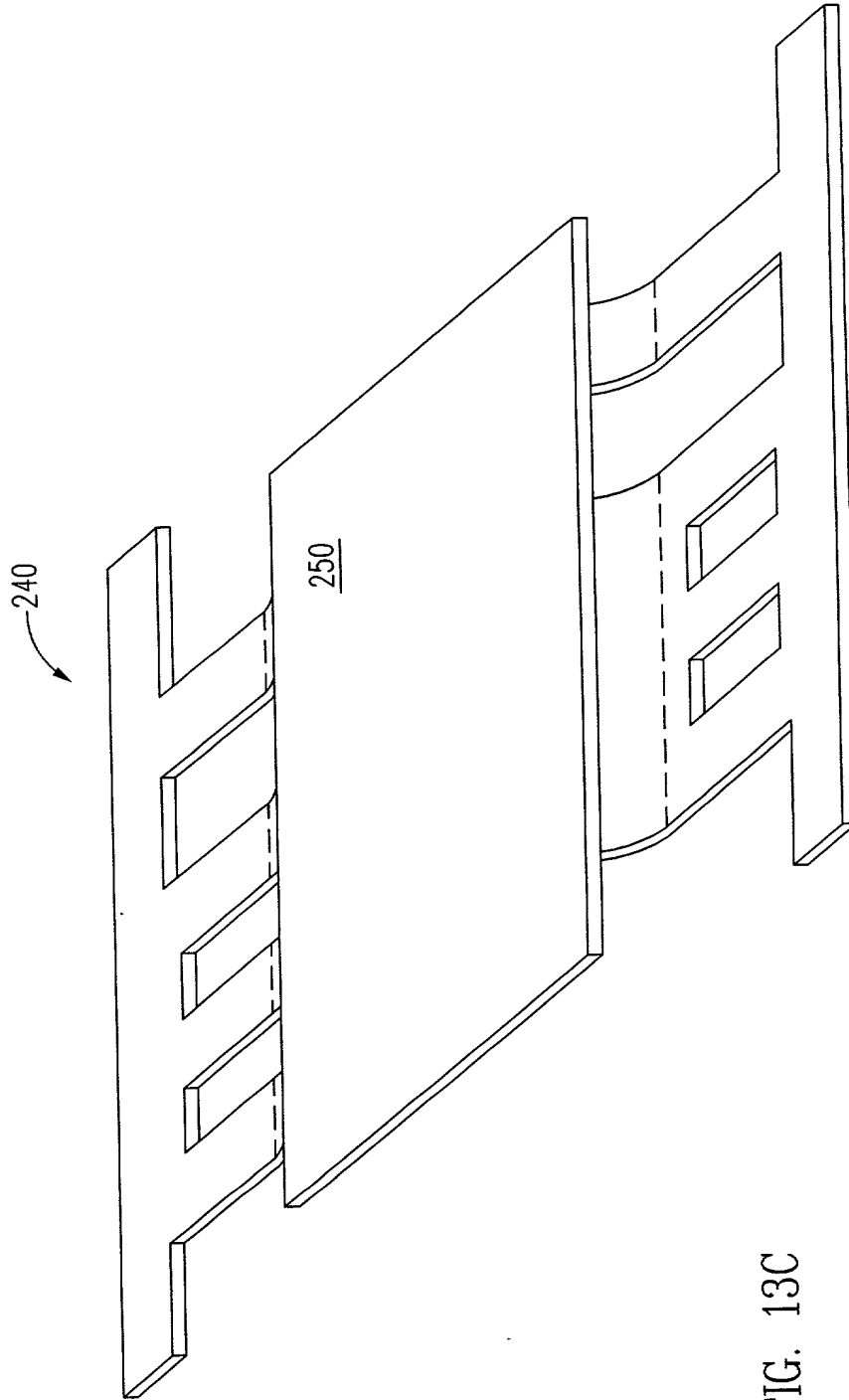


FIG. 13C

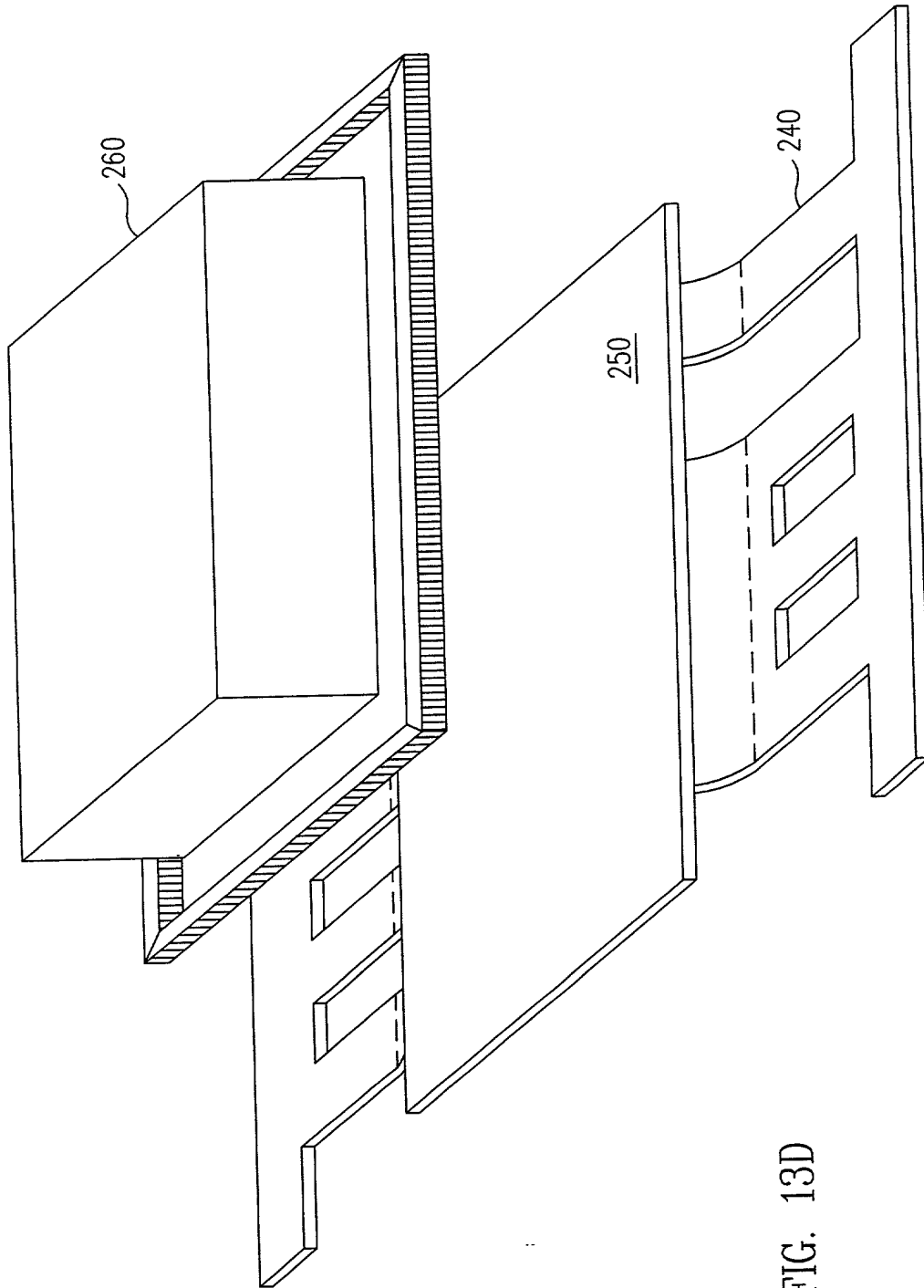


FIG. 13D

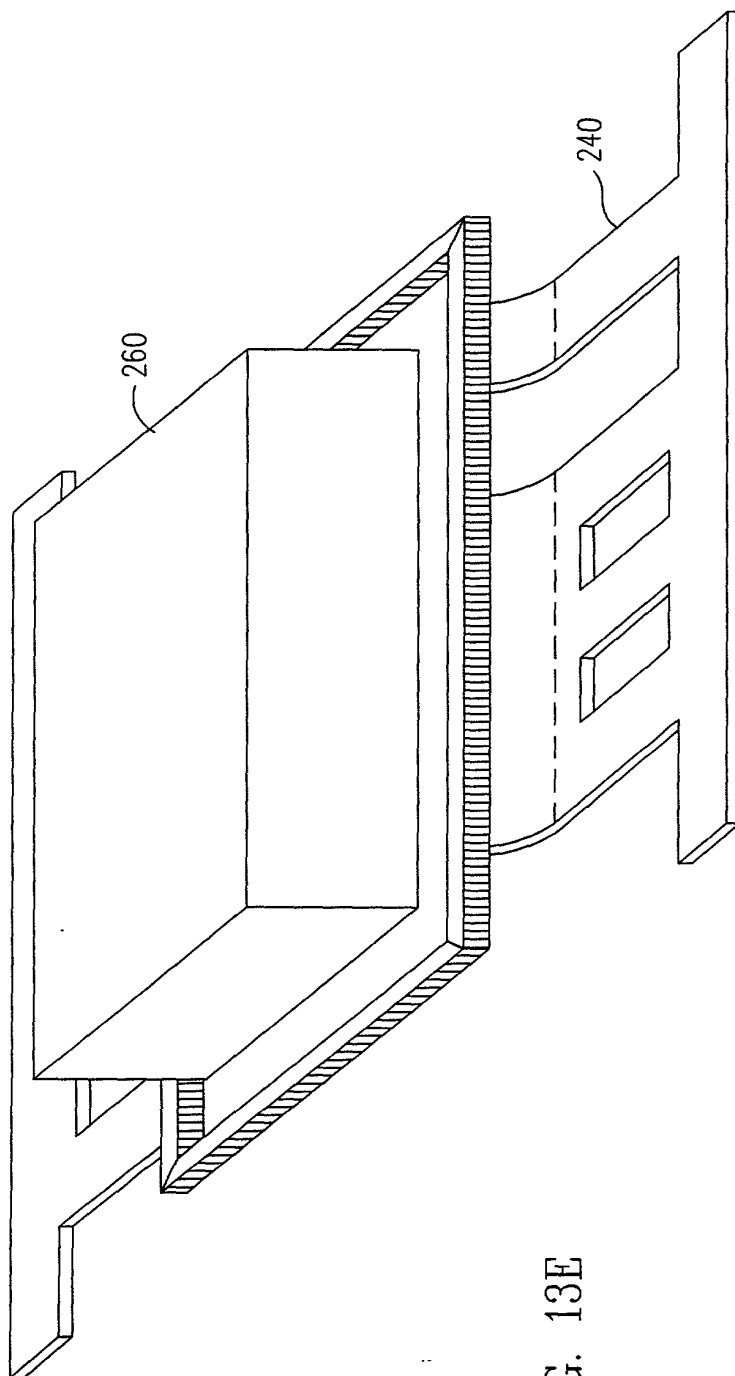


FIG. 13E

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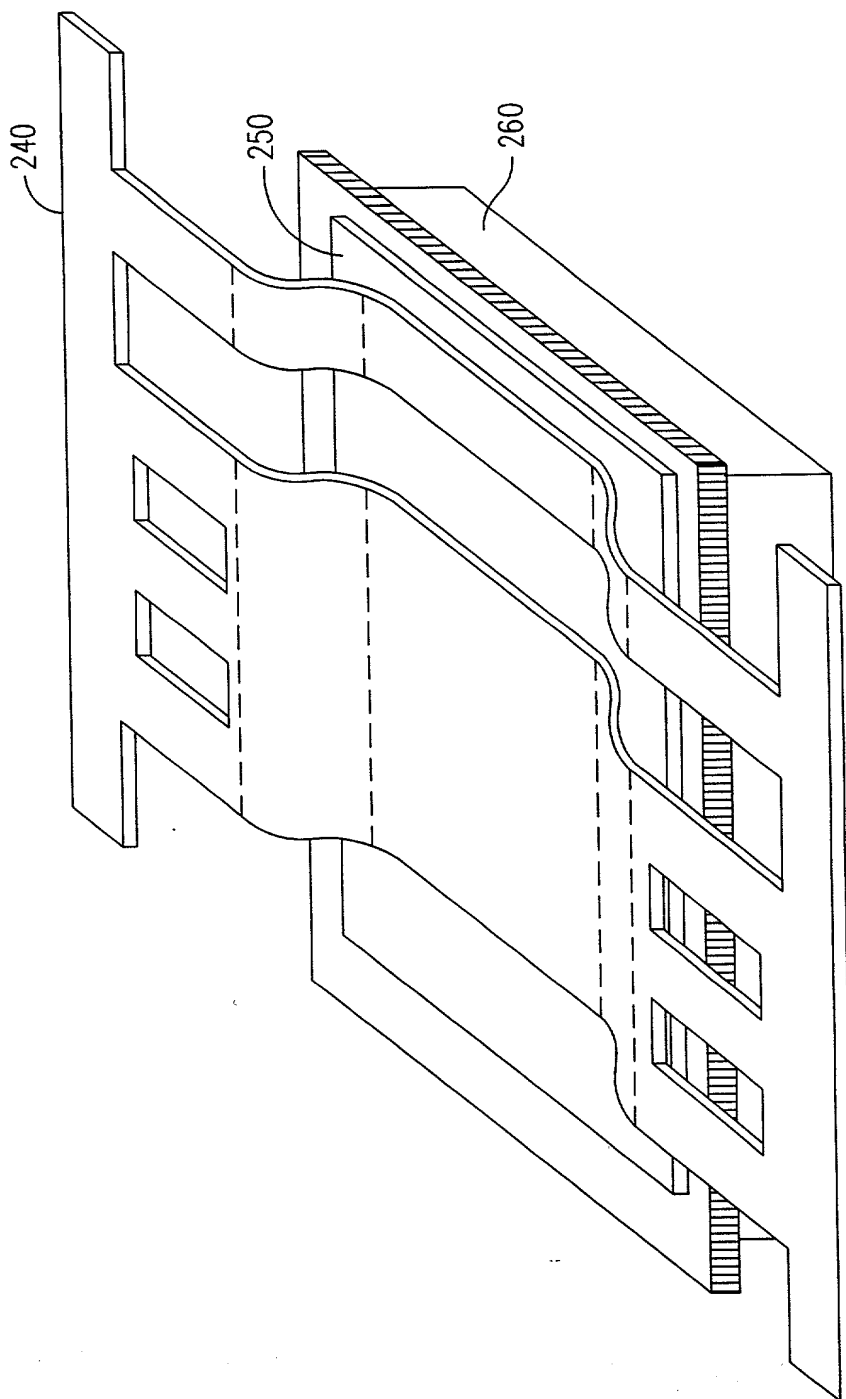


FIG. 13F